PCF21219 LCD driver for character displays Rev. 1 — 14 January 2014

Product data sheet

1. General description

The PCF21219 is a low power CMOS¹ LCD controller and driver, designed to drive a dot matrix LCD display of 2-lines by 16 characters or 1-line by 32 characters with 5×8 dot format. All necessary functions for the display are provided in a single chip, including on-chip generation of LCD bias voltages, resulting in a minimum of external components and lower system current consumption. The PCF21219 interfaces to most microcontrollers via a 4-bit or 8-bit bus or via the 2-wire I²C-bus. The chip contains a character generator and displays alphanumeric and kana (Japanese) characters.

The last letter in the type name, for example PCF21219DUGR, characterizes the built-in character set. Various character sets can be manufactured on request. In addition 16 user defined symbols (5×8 dot format) are available.

For a selection of NXP LCD character drivers, see <u>Table 50 on page 73</u>.

2. Features and benefits

- Single-chip LCD controller and driver
- 2-line display of up to 16 characters plus 160 icons or 1-line display of up to 32 characters plus 160 icons
- 5 × 7 character format plus cursor; 5 × 8 for kana (Japanese) and user defined symbols
- Reduced current consumption while displaying icons only
- On-chip:
 - Configurable 4, 3, or 2 times voltage multiplier generating LCD supply voltage, independent of V_{DD}, programmable by instruction (external supply also possible)
 - Temperature compensation of on-chip generated V_{LCDOUT}: -0.16 %/K to -0.24 %/K (programmable by instruction)
 - Generation of intermediate LCD bias voltages
 - Oscillator requires no external components (external clock also possible)
- Display Data RAM (DDRAM): 80 characters
- Character Generator ROM (CGROM): 240 characters (5 × 8)
- Character Generator RAM (CGRAM): 16 characters (5 × 8); 4 characters used to drive 160 icons
- 4-bit or 8-bit parallel bus and 2-wire I²C-bus interface
- Pin compatible with PCF2119
- Manufactured in silicon gate CMOS process
- 18 row and 80 column outputs

^{1.} The definition of the abbreviations and acronyms used in this data sheet can be found in Section 21.



LCD driver for character displays

- Multiplex rates 1:18 (2-line display or 1-line display), 1:9 (for 1-line display of up to 16 characters and 80 icons) and 1:2 (for icon only mode)
- Uses common 11 code instruction set (extended)
- Logic supply voltage: V_{DD1} V_{SS1} = 2.5 V to 5.5 V (chip may be driven with two battery cells)
- LCD supply voltage: $V_{LCDOUT} V_{SS2} = 2.5 \text{ V to } 6.5 \text{ V}$
- V_{LCD} generator supply voltage: V_{DD2} V_{SS2} = 2.5 V to 4 V and V_{DD3} V_{SS2} = 2.5 V to 4 V
- Direct mode to save current consumption for icon mode and multiplex drive mode 1:9 (depending on V_{DD2} value and LCD liquid properties)
- Very low current consumption
- Icon mode is used to save current. When only icons are displayed, a much lower LCD operating voltage can be used and the switching frequency of the LCD outputs is reduced; in most applications it is possible to use V_{DD} as LCD supply voltage

3. Applications

- Telecom equipment
- Portable instruments
- Point-of-sale terminals

4. Ordering information

Table 1. Ordering in	nformation							
Type number	Package	Package						
	Name	Description	Version					
PCF21219DUGR	bare die	168 bumps	PCF21219DUG					

4.1 Ordering options

Table 2. Ordering options												
Product type number	Sales item (12NC)	Orderable part number	IC revision	Delivery form								
PCF21219DUGR/DA	935303462033	PCF21219DUGR/DAZ	2	chips in tray; character set R								

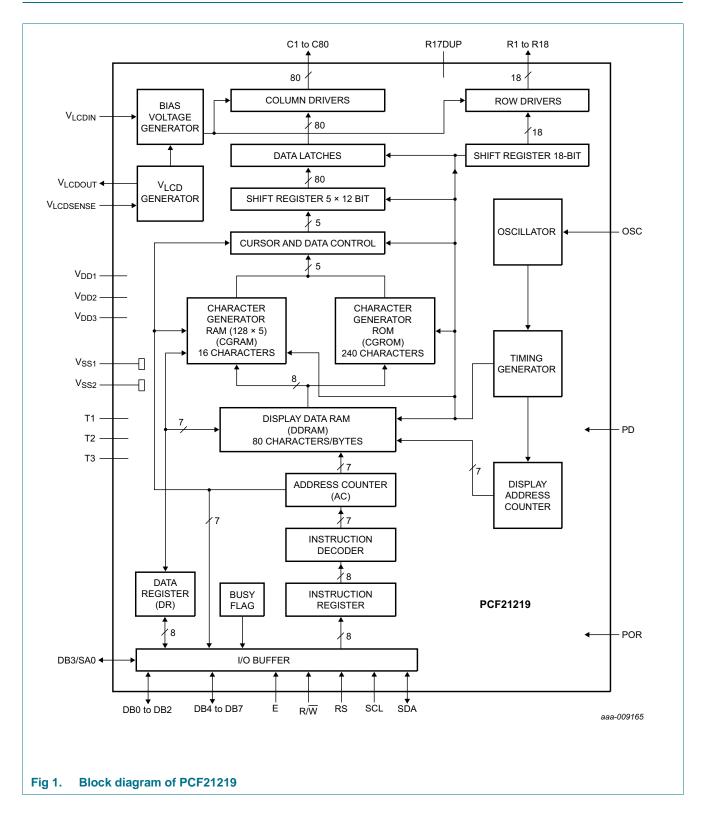
5. Marking

Table 3.	Marking codes	
Product ty	pe number	Marking code
PCF21219	DUGR/DA	PC21219-2

PCF21219

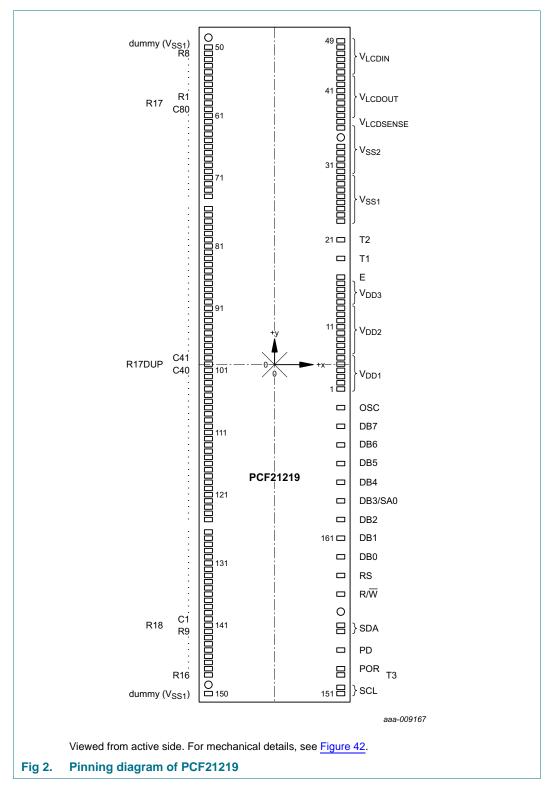
LCD driver for character displays

6. Block diagram



7. Pinning information

7.1 Pinning



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PCF21219

7.2 Pin description

Table 4. Pin description

Input or input/output pins must always be at a defined level (V_{SS} or V_{DD}) unless otherwise specified.

Symbol	Pin		Description
V _{DD1}	1 to 6		supply voltage 1 (logic)
V _{DD2}	7 to 14	<u>[1]</u>	supply voltage 2 (for high voltage generator)
V _{DD3}	15 to 18	<u>[1]</u>	supply voltage 3 (for high voltage generator)
E	19	[2]	data bus clock input
			 set HIGH to signal the start of a read or write operation
			 data is clocked in or out of the chip on the negative edge of the clock
T1 and T2	20 and 21		test pins
			 must be connected to V_{SS1}
V _{SS1}	22 to 29	[3]	ground supply voltage 1
			 for all circuits, except of high voltage generator
V _{SS2}	30 to 35	[3]	ground supply voltage 2
			 for high voltage generator
V _{LCDSENSE}	36		input for voltage multiplier regulation circuitry and for the bias level generation
			 if V_{LCD} is generated internally then this pin must be connected to V_{LCDOUT} and V_{LCDIN}
			 if V_{LCD} is generated externally then this pin must be connected to V_{LCDIN} only
V _{LCDOUT}	37 to 43		V _{LCD} output
			 if V_{LCD} is generated internally then this pin must be connected to V_{LCDIN} and to V_{LCDSENSE}
			 if V_{LCD} is generated externally then this pin must be left open-circuit
V _{LCDIN}	44 to 49		input for LCD bias level generator
			 if V_{LCD} is generated internally then this pin must be connected to V_{LCDOUT} and to V_{LCDSENSE}
			 if V_{LCD} is generated externally then this pin must be connected to V_{LCDSENSE} and to the external V_{LCD} power supply
dummy	50		-
R8 to R1,	51 to 58,		LCD row driver output
R17, R17DUP,	59, 100		 R17 has two pins: R17 and R17DUP
R18,	141,		 R17 and R18 drive the icons
R9 to R16	142 to 149		
C80 to C41,	60 to 99,		LCD column driver output
C40 to C1	101 to 140		
dummy	150		-
SCL	151 and 152	[4]	I ² C-bus serial clock input
Т3	153		test pin
			• open-circuit
			 not user accessible

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PCF21219

6 of 82

PCF21219

LCD driver for character displays

Symbol	Pin	Description
POR	154	external Power-On Reset (POR) input
PD	155	power-down mode selectfor normal operation, pin PD must be LOW
SDA	156 and 157 [4]	I ² C-bus serial data input/output
R/W	158	 read/write input pin R/W = HIGH selects the read operation pin R/W = LOW selects the write operation this pin has an internal pull-up resistor
RS	159	register select pinthis pin has an internal pull-up resistor
DB0 to DB2, DB3/SA0, DB4 to DB7	160 to 162, [5][6] 163, 164 to 167	 8 bit bidirectional data bus (bit 0 to bit 7) the 8-bit bidirectional data bus (3-state) transfers data between the microcontroller and the PCF21219 pin DB7 may be used as the busy flag, signalling that internal operations are not yet completed 4-bit operations the 4 higher order lines DB7 to DB4 are used, DB3 to DB0 must be left open-circuit data bus line DB3 has an alternative function (SA0) as the l²C-bus address pin each data line has its own internal pull-up resistor
OSC	168	 oscillator or external clock input when the on-chip oscillator is used this pin must be connected to V_{DD1}

Table 4. Pin description ...continued

[1] Always put $V_{DD2} = V_{DD3}$.

[2] When the I²C-bus is used, the parallel interface pin E must be LOW.

- [3] The substrate (rear side of the die) is at V_{SS} potential and must not be connected.
- [4] When the parallel bus is used, the pins SCL and SDA must be connected to V_{SS1} or V_{DD1}; they must not be left open-circuit.
- [5] In the I²C-bus read mode, ports DB7 to DB4 and DB2 to DB0 should be connected to V_{DD1} or left open-circuit.
- [6] When the 4-bit interface is used without reading out from the PCF21219 (bit R/W is set permanently to logic 0), the unused ports DB4 to DB0 can either be set to V_{SS1} or V_{DD1} instead of leaving them open-circuit.

8. Functional description

8.1 Oscillator and timing generator

The internal logic and the LCD drive signals of the PCF21219 are timed by the frequency f_{clk} which equals either the built in oscillator frequency f_{osc} or an external clock frequency $f_{osc(ext)}$.

8.1.1 Timing generator

The timing generator produces the various signals required to drive the internal circuitry. Internal chip operation is not disturbed by operations on the data buses.

8.1.2 Internal clock

To use the on-chip oscillator, pin OSC must be connected to V_{DD1}. The on-chip oscillator provides the clock signal for the display system. No external components are required.

8.1.3 External clock

If an external clock will be used, the input is at pin OSC. The resulting display frame frequency is given by:

$$f_{fr} = \frac{f_{clk}}{3072}$$

Remark: Only in the power-down mode the clock is allowed to be stopped (pin OSC connected to V_{SS}), otherwise the LCD is frozen in a DC state, which is not suitable for the liquid crystals.

8.2 Reset function and Power-On Reset (POR)

The PCF21219 must be reset externally when power is turned on. If no external reset is performed, the chip might start-up in an unwanted state.

For the external reset, pin POR has to be active HIGH. The reset has to be active for at least 3 oscillator periods in order for the reset to be executed. If the internal oscillator is used, the minimum reset activity time follows from the lowest possible oscillator frequency ($f_{osc} = 461 \text{ kHz}$, $t_{osc} \sim 2.17 \text{ }\mu\text{s}$, $3 \times t_{osc} \sim 6.51 \text{ }\mu\text{s}$). The internal oscillator start-up time is 200 μ s (typ) up to 300 μ s (max) after power-on. In case that an external oscillator is used, t_{osc} is dependent from $f_{osc(ext)}$.

Afterwards the chip executes the Clear_display instruction, which requires 165 oscillator cycles. After the reset the chip has the state shown in <u>Table 5</u> and is then ready for use.

(1)

State after reset

Table 5.

PCF21219

LCD driver for character displays

Table	J. State alter reset			
Step	Function	Control bit and register state	Description	Reference
1	Clear_display	-	-	Table 17
2	Entry_mode_set	bit I_D = 1	incremental cursor move direction	Table 19
		bit $S = 0$	no display shift	
3	Display_ctl	bit D = 0	display off	Table 20
		bit $C = 0$	cursor off	
4	Function_set	bit DL = 1	8-bit interface	Table 13
		bit $M = 0$		
		bit $SL = 0$	1:18 multiplex drive mode	
		bit $H = 0$	normal instruction set	
5	default address pointer to DDRAM ^[1]	-	-	Table 23
6	Icon_ctl	bit $IM = 0$	character mode, full display	Table 26
7	Screen_conf	bit $L = 0$	default configuration	Table 24
	Disp_conf	bit $P = 0$; bit $Q = 0$	default configurations	Table 25
8	Temp_ctl	bit TC1 = 0; bit TC2 = 0	default temperature coefficient	Table 28
9	VLCD_set	register $V_A = 0$; register $V_B = 0$	V _{LCD} generator off	Table 32
10	I ² C-bus interface reset	-	-	-
11	HV_gen	bit S1 = 1; bit S0 = 0	V _{LCD} generator set to 3 internal stages (4 voltage multipliers)	Table 30
-				

[1] The Busy Flag (BF) indicates the busy state (bit BF = 1) until initialization ends. The busy state lasts 2 ms. The chip may also be initialized by software (see <u>Table 44</u> and <u>Table 45</u>).

8.3 Power-down mode

The chip can be put into power-down mode by applying a HIGH-level to pin PD. In power-down mode all static currents are switched off (no internal oscillator, no bias level generation and all LCD outputs are internally connected to V_{SS}).

During power-down, information in the RAM and the chip state are preserved. Instruction execution during power-down is possible when pin OSC is externally clocked.

8.4 LCD supply voltage generator

The LCD supply voltage may be generated on-chip. The V_{LCD} generator is controlled by two internal 6-bit registers: V_A and V_B . Register V_A is programmed with the voltage for character mode and register V_B with the voltage for icon mode.

The nominal LCD operating voltage at room temperature is given by Equation 2:

$$V_{LCD(nom)} = V_x \times 0.08 + 1.82$$

(2)

Where V_x is the integer value of the register V_A or V_B .

V_{LCD} is sometimes referred as the LCD operating voltage (V_{oper}).

8.4.1 Programming ranges

Possible values for V_A and V_B are between 0 to 63.

Table 6. Values of V_A and V_B and the corresponding V_{LCD} values

All values at $T_{ref} = 27 \ ^{\circ}C$; allowed values are highlighted.

Integer values of V_A and V_B	Corresponding value of V _{LCD} in V	Integer values of V _A and V _B	Corresponding value of V _{LCD} in V	Integer values of V _A and V _B	Corresponding value of V _{LCD} in V
0	V _{LCD} switched off	22	3.58	44	5.34
1	1.90	23	3.66	45	5.42
2	1.98	24	3.74	46	5.50
3	2.06	25	3.82	47	5.58
4	2.14	26	3.90	48	5.66
5	2.22	27	3.98	49	5.74
6	2.30	28	4.06	50	5.82
7	2.38	29	4.14	51	5.90
8	2.46	30	4.22	52	5.98
9	2.54	31	4.30	53	6.06
10	2.62	32	4.38	54	6.14
11	2.70	33	4.46	55	6.22
12	2.78	34	4.54	56	6.30
13	2.86	35	4.62	57	6.38
14	2.94	36	4.70	58	6.46
15	3.02	37	4.78	59	6.54
16	3.10	38	4.86	60	6.62
17	3.18	39	4.94	61	6.70
18	3.26	40	5.02	62	6.78
19	3.34	41	5.10	63	6.86
20	3.42	42	5.18		
21	3.50	43	5.26		

Remarks:

- Values producing more than 6.5 V at operating temperature are not allowed. Operation above this voltage may damage the device. When programming the operating voltage, the temperature coefficient of V_{LCDOUT} must be taken into account.
- Values below 2.5 V are below the specified operating range of the chip and are therefore not allowed.

When the LCD supply voltage is generated on-chip, the V_{LCD} pins should be decoupled to V_{SS} with a suitable capacitor. The generated V_{LCDOUT} is independent of V_{DD} and is temperature compensated.

In Equation 2 the internal charge pump is not considered. However, if the supplied voltage to V_{DD2} and V_{DD3} is below the required V_{LCD}, it is necessary to use the internal charge pump. The multiplication factor indicates the number of stages used to increase the voltage. At multiplication factor 2 one, at multiplication factor 3 two and at multiplication factor 4, three stages are used. A multiplication factor of for example, 4 does not mean that a voltage of $4 \times V_{DD2,3}$ is generated in the internal high-voltage generator. The charge pump is part of a control loop. This means that the control loop aims to regulate V_{LCD} at the programmed value.

The ITO track resistance limit the speed by which the capacitors can be charged. The multiplication factor exceeds the required V_{LCD} under all circumstances (that is, at low temperatures and along with the temperature compensation, see <u>Section 10.2.2.4</u>). If still a higher multiplication factor is chosen, V_{LCD} will remain as set by <u>Equation 2</u> but the ripple will increase. The increase in ripple can be counteracted by increasing the external decoupling capacitor at V_{LCD} . A higher multiplication factor will also result in a higher current consumption (see <u>Section 16.6</u>). However the current that can be delivered will be higher, for example, for larger display area.

When the V_{LCD} generator and the direct mode are switched off, an external voltage may be supplied at connected pins V_{LCDIN} and V_{LCDOUT}. V_{LCDIN} and V_{LCDOUT} may be higher or lower than V_{DD2}.

In direct mode (see Icon_ctl instruction, <u>Section 10.2.3.3</u>) the internal V_{LCD} generator is turned off and the V_{LCDOUT} output voltage is directly connected to V_{DD2}. This reduces the current consumption depending on V_{DD2} value and LCD liquid properties.

The V_{LCD} generator ensures that, as long as V_{DD2} and V_{DD3} are in the valid range (2.5 V to 4 V), the required peak voltage V_{LCD} = 6.5 V can be generated at any time.

8.5 LCD bias voltage generator

The intermediate bias voltages for the LCD display are also generated on-chip. This removes the need for an external resistive bias chain and significantly reduces the system current consumption. The optimum value of V_{LCD} depends on the multiplex rate, the LCD threshold voltage (V_{th}) and the number of bias levels. Using a 5-level bias scheme for the 1:18 multiplex rate allows $V_{LCD} < 5 V$ for most LCD liquids.

The intermediate bias levels for the different multiplex rates are shown in <u>Table 7</u>. These bias levels are automatically set to the given values when switching to the corresponding multiplex rate.

Multiplex	Number of	Bias voltages										
rate	bias levels	V ₁	V ₂	V ₃	V ₄	V ₅	V ₆					
1:18	5	V _{LCD}	$\frac{3}{4}(V_{LCD} - V_{SS})$	$\frac{l}{2}(V_{LCD} - V_{SS})$	$\frac{l}{2}(V_{LCD} - V_{SS})$	$\frac{l}{4}(V_{LCD} - V_{SS})$	V _{SS}					
1:9	5	V_{LCD}	$\frac{3}{4}(V_{LCD} - V_{SS})$	$\frac{l}{2}(V_{LCD} - V_{SS})$	$\frac{l}{2}(V_{LCD} - V_{SS})$	$\frac{l}{4}(V_{LCD} - V_{SS})$	V_{SS}					
1:2	4	V_{LCD}	$\frac{2}{3}(V_{LCD} - V_{SS})$	$\frac{2}{3}(V_{LCD} - V_{SS})$	$\frac{l}{3}(V_{LCD} - V_{SS})$	$\frac{l}{3}(V_{LCD} - V_{SS})$	V_{SS}					

Table 7. Bias levels as a function of multiplex rate

The RMS on-state voltage ($V_{on(RMS)}$) for the LCD is calculated with <u>Equation 3</u> and the RMS off-state voltage ($V_{off(RMS)}$) with <u>Equation 4</u>:

$$V_{on(RMS)} = v_{LCD} \sqrt{\frac{a^2 + 2a + n}{n \times (1 + a)^2}}$$
(3)

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a^2 - 2a + n}{n \times (1 + a)^2}}$$
(4)

where the values of a are

a = 2 for $\frac{1}{4}$ bias a = 3 for $\frac{1}{5}$ bias

and the values for n are

n = 2 for 1:2 multiplex rate

n = 9 for 1:9 multiplex rate

n = 18 for 1:18 multiplex rate.

Discrimination (D) is the ratio of $V_{on(RMS)}$ to $V_{off(RMS)}$ and is determined from Equation 5.

Discrimination is a term which is defined as the ratio of the on and off RMS voltage across a segment. It can be thought of as a measurement of contrast.

$$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{(a+1)^2 + (n-1)}{(a-1)^2 + (n-1)}}$$
(5)

8.5.1 Electro-optical performance

Suitable values for $V_{on(RMS)}$ and $V_{off(RMS)}$ are dependant on the LCD liquid used. The RMS voltage, at which a pixel will be switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at V_{low}) and the other at 90 % relative transmission (at V_{high}), see Figure 3. For a good contrast performance, the following rules should be followed:

$$V_{on(RMS)} \ge V_{high}$$

(6)

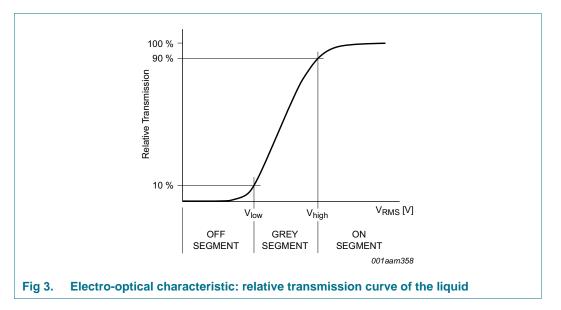
 $V_{off(RMS)} \le V_{low}$

(7)

 $V_{on(RMS)}$ and $V_{off(RMS)}$ are properties of the display driver and are affected by the selection of a, n (see <u>Equation 3</u> to <u>Equation 5</u>) and the V_{LCD} voltage.

 V_{low} and V_{high} are properties of the LCD liquid and can be provided by the module manufacturer.

It is important to match the module properties to those of the driver in order to achieve optimum performance.



8.6 LCD row and column drivers

The PCF21219 contains 18 row and 80 column drivers, which drive the appropriate LCD bias voltages in sequence to the display in accordance with the data to be displayed. R17 and R18 drive the icon rows. Unused outputs should be left open.

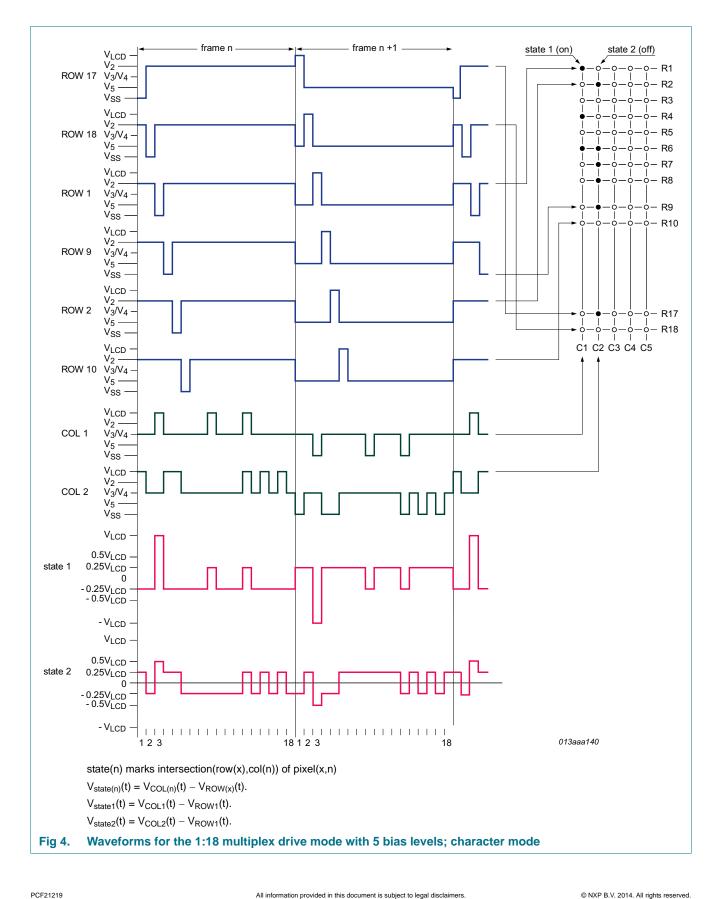
The bias voltages and the timing are selected automatically when the number of lines in the display is selected. Figure 4 to Figure 6 show typical waveforms.

The waveforms used to drive LC displays inherently produce a DC voltage across the display cell. The PCF21219 compensates for the DC voltage by inverting the waveforms on alternate frames (called frame inversion mode or driving scheme A).

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PCF21219

LCD driver for character displays

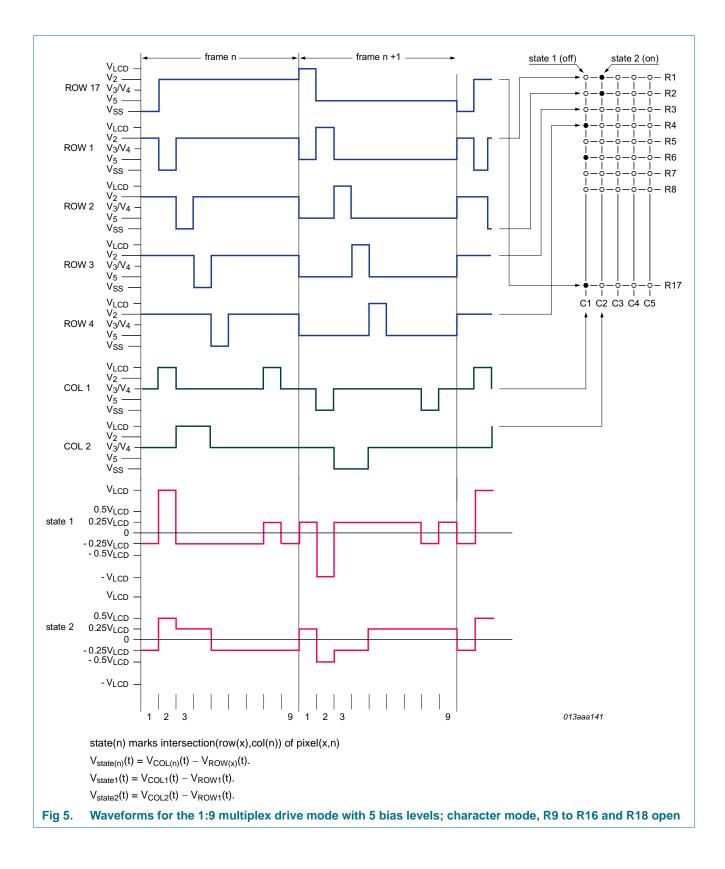


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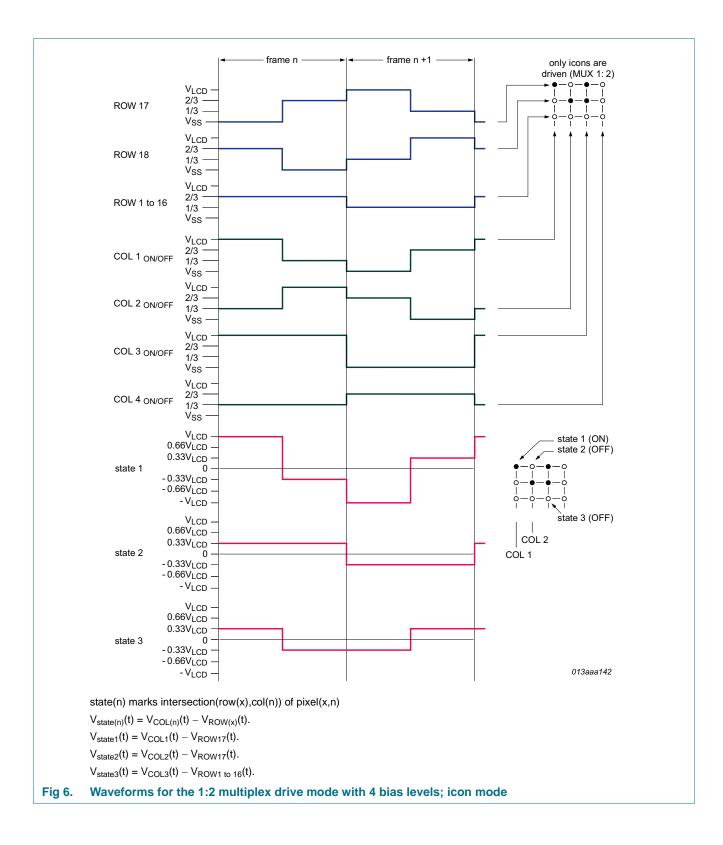
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PCF21219

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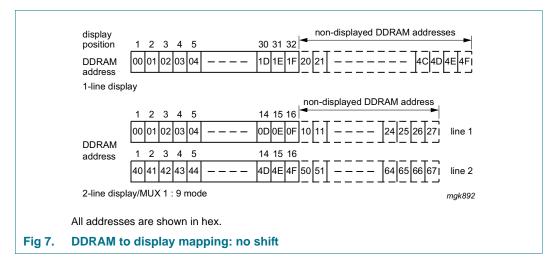


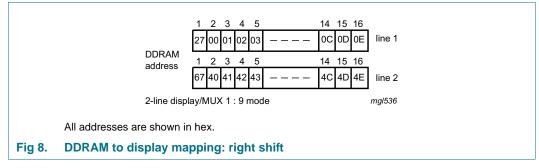
9. Display data RAM and ROM

9.1 DDRAM

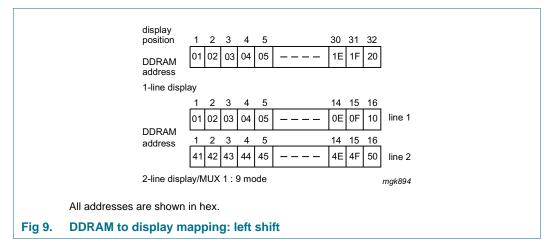
The Display Data RAM (DDRAM) stores up to 80 characters of display data represented by 8-bit character codes. RAM locations which are not used for storing display data can be used as general purpose RAM.

The basic RAM to display addressing scheme is shown in <u>Figure 7</u>, <u>Figure 8</u> and <u>Figure 9</u>. With no display shift the characters represented by the codes in the first 32 RAM locations starting at address 00h are displayed in line 1.





LCD driver for character displays



When data is written to or read from the DDRAM, wrap-around occurs from the end of one line to the start of the next line. When the display is shifted each line wraps around within itself, independently of the others. Thus all lines are shifted and wrapped around together. The address ranges and wrap-around operations for the various modes are shown in Table 8.

Mode	1 × 32	2 × 16	1 × 16
Address space	00h to 4Fh	00h to 27h; 40h to 67h	00h to 27h
Read/write wrap-around (moves to next line)	4Fh to 00h	27h to 40h; 67h to 00h	27h to 00h
Display shift wrap-around (stays within line)	4Fh to 00h	27h to 00h; 67h to 40h	27h to 00h

Table 8. Address space and wrap-around operation

9.2 CGROM

The Character Generator ROM (CGROM) contains 240 character patterns in a 5×8 dot format from 8-bit character codes.

LCD driver for character displays

lower 4 bits	upper 4 bits	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
xxxx	0000	1	4	ŀ	·#·	•											
хххх	0001	2							•								
xxxx	0010	3			.					: ::::::::::::::::::::::::::::::::::::	i i i	::					.
хххх	0011	4			1				::::						::	.	
хххх	0100	5		·									4				÷
xxxx	0101	6		1		• • •							:				I
xxxx	0110	7	÷.						÷						÷	÷	÷
xxxx	0111	8		•	.						Ŧ	:				•	
xxxx	1000	9			i i				2								2
xxxx	1001	10															·
xxxx	1010	11	·							Ĩ	••••• ••••	:	# #				
xxxx	1011	12						K.					# ;;	K			
xxxx	1100	13										:					
xxxx	1101	14	.		÷.							•••••				[]]	
xxxx	1110	15		·							 :					! "	
хххх	1111	16							!								

The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 10. Character set 'R' in CGROM

9.3 CGRAM

Up to 16 user defined characters may be stored in the Character Generator RAM (CGRAM).

The CGROM and CGRAM use a common address space, of which the first column is reserved for the CGRAM (see Figure 10). An example of a user defined character is given in Section 16.14 on page 63.

character codes (DDRAM data)	CGRAM address	character patterns (CGRAM data)	character code (CGRAM data)					
6 5 4 3 2 1 0	6 5 4 3 2 1 0	4 3 2 1 0	4 3 2 1 0					
higher lower – order order → bits bits	higher lower ← order order → bits bits	higher lower ←order order → bits bits						
0 0 0 0 0 0 0 0 (4)	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	0 0 0 0 0 character 0 0 0 0 character 0 0 0 0 character 0 0 0 0 character 0 0 0 0 0 0 0 character 0 0 0 0 0 0 character 0 0 0 0 0 0 0 character 0 0 0 0 0 0 0 0 0 character 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$					
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0 0 0 0 0 1 0	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$							
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	1 1 1 1 0 0 1 1 1 1 0 1 1 1 1 1 0 1 1 1 1 1 1 0 1 1 1 1 1 0 1 1 1 1 1 1		coa072					

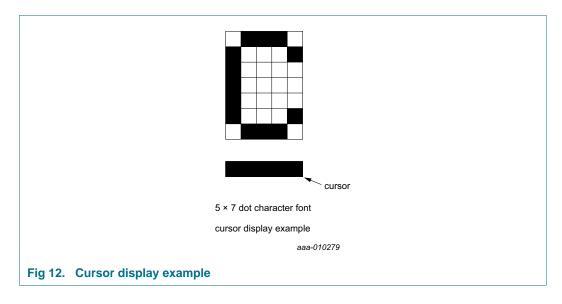
Figure 11 shows the addressing principle for the CGRAM.

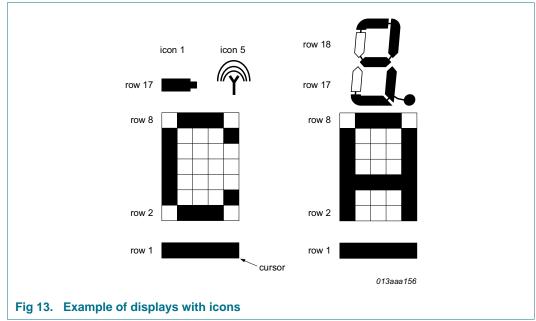
- by iog aμμ
- (3) Character pattern column positions correspond to CGRAM data bit 0 to bit 4, as shown in Figure 10.
- (4) As shown in Figure 10, CGRAM character patterns are selected when character code bit 4 to bit 7 are all logic 0. CGRAM data = logic 1 corresponds to selection for display.
- (5) Only bit 0 to bit 5 of the CGRAM address are set by the Set_CGRAM command. Bit 6 can be set using the Set_DDRAM command in the valid address range or by using the auto-increment feature during CGRAM write. All bits from bit 0 to bit 6 can be read using the BF_AC instruction.

Fig 11. Relationship between CGRAM addresses, data and display patterns

9.4 Cursor control circuit

The cursor control circuit generates the cursor underline as shown in <u>Figure 12</u> at the DDRAM address contained in the address counter.





10. Registers

The PCF21219 has two 8-bit registers, an instruction register and a data register. Only these two registers can be directly controlled by the microcontroller. Before an internal operation, the control information is stored temporarily in these registers, to allow interfacing to various types of microcontrollers which operate at different speeds or to allow interface to peripheral control ICs.

The instruction set for the parallel interface is shown in <u>Table 12</u> together with their execution time. Details about the parallel interface can be found in <u>Section 11.1</u>. Examples of operations on a 4-bit bus are given in <u>Table 39</u>, on a 8-bit bus in <u>Table 40</u>, <u>Table 41</u> and <u>Table 42</u>.

When using the l²C-bus, the instruction has to be commenced with a control byte as shown in <u>Table 9</u>. Details about the l²C-bus interface can be found in <u>Section 11.2</u>. An example of operations on the l²C-bus is given in <u>Table 43</u>.

Table 9. Instruction set for I²C-bus commands

Cont	trol by	yte						Com								I ² C-bus command
СО	RS	0	0	0	0	0	0	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	<u>[1]</u>

[1] R/\overline{W} is set together with the slave address (see <u>Table 33</u>).

Table 10. Control byte bit description

7 CO 0 last control byte 1 another control byte follows after data/command 6 RS 0 instruction register selected 1 data register selected 5 to 0 data register selected	Bit	Symbol	Value	Description
6 RS 0 instruction register selected 1 data register selected	7	CO	0	last control byte
1 data register selected			1	another control byte follows after data/command
	6	RS	0	instruction register selected
5 to 0 default logic 0			1	data register selected
	5 to 0	-	0	default logic 0

Instructions are of 4 types, those that:

- 1. Designate PCF21219 functions like display format, data length, etc.
- 2. Set internal RAM addresses
- 3. Perform data transfer with internal RAM
- 4. Others, like read 'busy flag' and read 'address counter'

In normal use, type 3 instructions are used most frequently. However, automatic incrementing by 1 (or decrementing by 1) of internal RAM addresses after each data write lessens the microcontroller program load. The display shift in particular can be performed concurrently with display data write, enabling the designer to develop systems in minimum time with maximum programming efficiency.

During internal operation, no instructions other than the BF_AC instruction will be executed. Because the busy flag is set to logic 1 while an instruction is being executed, check to ensure it is logic 0 before sending the next instruction or wait for the maximum instruction execution time, as given in <u>Table 12</u>. An instruction sent while the busy flag is logic 1 will not be executed.

PCF21219

The RS bit determines which register will be accessed and the R/\overline{W} bit indicates if it is a read or a write operation (see <u>Table 11</u>).

Table 11.	Register acce	Register access selection		
Symbol	Value	Description		
RS register select		register select		
	0	instruction register ^[1]		
	1	data register ^[2]		
R/W		read/write		
	0	write operation		
	1	read operation		

[1] There is only write access to the instruction register, but read access to the busy flag (BF) and the address counter (AC) of the BF_AC instruction (see Section 10.2.1.2).

[2] Write and read access.

Details of the instructions are explained in subsequent sections.

10.1 Data register

The data register temporarily stores data to be read from the DDRAM and CGRAM. Prior to being read by the Read_data instruction, data from the DDRAM or CGRAM, corresponding to the address in the instruction register, is written to the data register.

10.2 Instruction register

The instruction register stores instruction codes such as Clear_display, Curs_disp_shift, and address information for the Display Data RAM (DDRAM) and Character Generator RAM (CGRAM). The instruction register can be written to but not read from by the system controller.

The instruction register is sectioned into basic, standard and extended instructions. Bit H = 1 of the Function_set instruction (see <u>Section 10.2.1.1</u>) sets the chip into extended instruction set mode.

PCF21219

LCD driver for character displays

Instruction	Bits ^[1]	1									Required	Reference
	RS	R/W	7	6	5	4	3	2	1	0	clock cycles ^[2]	
Basic instructions (bit H =	0 or 1)	Ì									
NOP [3]	0	0	0	0	0	0	0	0	0	0	3	-
Function_set	0	0	0	0	1	DL	0	Μ	SL	Н	3	Section 10.2.1.1
BF_AC	0	1	BF	AC							0	Section 10.2.1.2
Read_data	1	1	READ	_DATA	۱.						3	Section 10.2.1.3
Write_data	1	0	WRIT	E_DAT	A						3	Section 10.2.1.4
Standard instruction	ns (bit	H = 0)										
Clear_display	0	0	0	0	0	0	0	0	0	1	165	Section 10.2.2.1
Return_home	0	0	0	0	0	0	0	0	1	0	3	Section 10.2.2.2
Entry_mode_set	0	0	0	0	0	0	0	1	I_D	S	3	Section 10.2.2.3
Display_ctl	0	0	0	0	0	0	1	D	С	0	3	Section 10.2.2.4
Curs_disp_shift	0	0	0	0	0	1	SC	RL	0	0	3	Section 10.2.2.5
Set_CGRAM	0	0	0	1	ACG			3	Section 10.2.2.6			
Set_DDRAM	0	0	1	ADD					3	Section 10.2.2.7		
Extended instructio	ns (bit	H = 1)										
Reserved [4]	0	0	0	0	0	0	0	0	0	1	-	-
Screen_conf	0	0	0	0	0	0	0	0	1	L	3	Section 10.2.3.1
Disp_conf	0	0	0	0	0	0	0	1	Р	Q	3	Section 10.2.3.2
Icon_ctl	0	0	0	0	0	0	1	IM	0	DM	3	Section 10.2.3.3
Temp_ctl	0	0	0	0	0	1	0	0	TC1	TC2	3	Section 10.2.3.4
HV_gen	0	0	0	1	0	0	0	0	S1	S0	3	Section 10.2.3.5
VLCD_set	0	0	1	V	VA or	VB					3	Section 10.2.3.6

Table 12. Instruction register overview

[1] The bits 0 to 7 correspond with the data bus lines DB0 to DB7.

[2] fosc cycles.

[3] No operation.

[4] Do not use.

10.2.1 Basic instructions (bit H = 0 or 1)

10.2.1.1 Function_set

Bit	Symbol	Value		Description
RS	-	0		see Table 11
R/W	-	0		
7 to 5	-	001		fixed value
4	DL			interface data length (for parallel mode only)
	0	<u>[1]</u>	2×4 bits (DB7 to DB4)	
		1	[2]	8 bits (DB7 to DB0)
3	-	0		unused
2 M			[3]	number of display lines
	0		1 line × 32 characters	
		1	[4]	2 line × 16 characters
1	SL			multiplex mode
		0		1:18 multiplex drive mode, 1×32 or 2×16 character display
		1	[4][5]	1:9 multiplex drive mode, 1×16 character display
0 Н	Н			instruction set control
		0		basic instruction set plus standard instruction set
		1	<u>[4]</u>	basic instruction set plus extended instruction set

[1] When 4-bit width is selected, data is transmitted in two cycles using the parallel-bus. In a 4-bit application ports DB3 to DB0 should be left open-circuit (internal pull-ups).

- [2] Default value after power-on in I²C-bus mode.
- [3] No impact if SL = 1.
- [4] Due to the internal pull-ups on DB3 to DB0 in a 4-bit application, the first Function_set after power-on sets bits M, SL and H to logic 1. A second Function_set must be sent to set bits M, SL and H to the required values.
- [5] Independent of bit M and bit L of the Screen_conf instruction (see Section 10.2.3.1). Only row 1 to row 8 and row 17 are used. All other rows must be left open-circuit. The DDRAM map is the same as in the 2×16 character display mode, however, the second line cannot be displayed.

10.2.1.2 BF_AC instructions

Bit	Symbol	Value	Description
RS	-	0	see <u>Table 11</u>
R/W	-	1	
7	BF		[1] read busy flag
		0	next instruction will be executed
		1	internal operation is in progress; next instruction will not be executed until BF = 0
6 to 0	AC	0000000 to 111111	read address counter

[1] It is recommended that the BF status is checked before the next write operation is started.

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PCF21219

Busy flag: The busy flag indicates the internal status of the PCF21219. A logic 1 indicates that the chip is busy and further instructions will not be accepted. The busy flag is output to pin DB7 when bit RS = 0 and bit R/W = 1. Instructions should only be started after checking that the busy flag is at logic 0 or after waiting for the required number of cycles.

Address counter: The address counter is used by both CGRAM and DDRAM, and its value is determined by the previous Set_CGRAM and Set_DDRAM instruction. After a read/write operation the address counter is automatically incremented or decremented by 1. The address counter value is output to the bus (DB6 to DB0) when bit RS = 0 and bit R/W = 1.

10.2.1.3 Read_data

Table 15.	Read	data bi	t description
	Itcuu_		L desemption

Bit	Symbol	Value	Description
RS	-	1	see Table 11
R/W	-	1	
7 to 0	READ_DATA	00000000 to 11111111	read data from CGRAM or DDRAM

Read_data from CGRAM or DDRAM: Read_data reads binary 8-bit data from the CGRAM or DDRAM. The most recent 'set address' command (Set_CGRAM or Set_DDRAM) determines whether the CGRAM or DDRAM is to be read.

The Read_data instruction gates the content of the data register to the bus while pin E is HIGH. After pin E goes LOW again, internal operation increments (or decrements) the address counter and stores RAM data corresponding to the new address counter into the data register.

There are only three instructions that update the data register:

- Set_CGRAM
- Set_DDRAM
- Read_data from CGRAM or DDRAM

Other instructions (e.g. Write_data, Curs_disp_shift, Clear_display and Return_home) do not modify the value of the data register.

10.2.1.4 Write_data

Table 16	Table 16. Write_data bit description					
Bit	Symbol	Value	Description			
RS	-	1	see Table 11			
R/W	-	0				
7 to 0	WRITE_DATA	00000000 to 11111111	write data to CGRAM or DDRAM			

Write_data to CGRAM or DDRAM: Write_data writes binary 8-bit data to the CGRAM or the DDRAM.

The previous Set_CGRAM or Set_DDRAM command determines if data is written into CGRAM or DDRAM. After writing, the address counter automatically increments or decrements by 1, in accordance with the Entry_mode_set (see <u>Section 10.2.2.3</u>). Only bit 4 to bit 0 of CGRAM data are valid, bit 7 to bit 5 are 'don't care'.

10.2.2 Standard instructions (bit H = 0)

10.2.2.1 Clear_display

Table 17	Table 17. Clear_display bit description				
Bit	Symbol	Value	Description		
RS	-	0	see Table 11		
R/W	-	0			
7 to 0	-	00000001	fixed value		

Clear_display: writes usually the character code 20h (blank pattern) into all DDRAM addresses except for the character set 'R' where the character code 20h is not a blank pattern.

When using character set 'R', the following alternative instruction set has to be used:

- 1. Switch display off (Display_ctl, bit D = 0).
- 2. Write a blank pattern into all DDRAM addresses (Write_data).
- 3. Switch display on (Display_ctl, bit D = 1).

In addition Clear_display

- sets the DDRAM address counter to logic 0
- returns the display to its original position, if it was shifted. Thus, the display disappears and the cursor goes to the left edge of the display
- sets entry mode bit I_D = 1 (increment mode); bit S of entry mode does not change

The instruction Clear_display requires extra execution time. This may be allowed by checking the busy flag bit BF or by waiting until the 165 clock cycles have elapsed. The latter must be applied where no read-back options are foreseen, as in some Chip-On-Glass (COG) applications.

10.2.2.2 Return_home

Table 18. Return_home bit description

Bit	Symbol	Value	Description
RS	-	0	see Table 11
R/W	-	0	
7 to 0	-	00000010	fixed value

Return_home: Sets the DDRAM address counter to logic 0 and switches a shifted display back to an unshifted state. The DDRAM content remains unchanged. The cursor goes to the left of the first display line. Bit I_D and bit S of the Entry_mode_set instruction remain unchanged.

Bit	Symbol	Value	Description
RS	-	0	see <u>Table 11</u>
R/W	-	0	
7 to 2	-	000001	fixed value
1 I_D			address increment or decrement
	0	DDRAM or CGRAM address decrements by 1, cursor moves to the left	
		1	DDRAM or CGRAM address increments by 1, cursor moves to the right
0	S		shift display to the left or right
		0	display does not shift
		1	display shifts

10.2.2.3 Entry_mode_set

Bit I_D: When bit $I_D = 1$ the DDRAM or CGRAM address increments by 1 when data is written into or read from the DDRAM or CGRAM. The cursor position moves to the right.

When bit $I_D = 0$ the DDRAM or CGRAM address decrements by 1 when data is written into or read from the DDRAM or CGRAM. The cursor position moves to the left.

The cursor underline is inhibited when the CGRAM is accessed.

Bit S: When bit S = 0, the display does not shift.

During DDRAM write, when bit S = 1 and bit $I_D = 0$, the entire display shifts to the right; when bit S = 1 and bit $I_D = 1$, the entire display shifts to the left.

Thus it appears as if the cursor stands still and the display moves. The display does not shift when reading from the DDRAM, or when writing to or reading from the CGRAM.

10.2.2.4 Display_ctl instructions

Table 2	Table 20. Display_ctl bit description						
Bit	Symbol	Value	Description				
RS	-	0	see Table 11				
R/W	-	0					
7 to 3	-	00001	fixed value				
2	D		display on or off				
		0	display is off; chip is in power-down mode				
		1	display is on				
1	С		cursor on or off				
		0	cursor is off				
		1	cursor is on				
0	-	0	fixed value				

Bit D: The display is on when bit D = 1 and off when bit D = 0. Display data in the DDRAM is not affected and can be displayed immediately by setting bit D = 1.

When the display is off (bit D = 0) the chip is in partial power-down mode:

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PCF21219

- The LCD outputs are connected to V_{SS}
- The V_{LCD} generator and bias generator are turned off

Three oscillator cycles are required after sending the 'display off' instruction to ensure all outputs are at V_{SS} , afterwards the oscillator can be stopped. If the oscillator is running during partial power-down mode ('display off') the chip can still execute instructions. Even lower current consumption is obtained by inhibiting the oscillator (pin OSC to V_{SS}).

To ensure $I_{DD} < 1 \ \mu A$:

- the parallel bus ports DB7 to DB0 should be connected to V_{DD}
- pins RS and R/W should be connected to V_{DD} or left open-circuit
- pin PD should be connected to V_{DD}

Recovery from power-down mode:

- pin PD should be connected back to V_{SS}
- if necessary pin OSC should be connected back to V_{DD}
- a Display_ctl instruction with bit D = 1 should be sent

Bit C: The cursor is displayed when bit C = 1 and inhibited when bit C = 0. Even if the cursor disappears, bit I_D and bit S (see <u>Section 10.2.2.3</u>) remain in operation during display data write. The cursor is displayed using 5 dots in the 8th line (see Figure 12).

10.2.2.5 Curs_disp_shift

Bit	Symbol	Value	Description
RS	-	0	see Table 11
R/W	-	0	
7 to 4	-	0001	fixed value
3	SC		cursor move or display shift
		0	move cursor
		1	shift display
2	RL		shift or move to the right or left
		0	left shift or move
		1	right shift or move
1 to 0	-	00	fixed value

Table 21. Curs_disp_shift bit description

Bits SC and RL: Curs_disp_shift moves the cursor position or the display to the right or left without writing or reading display data. This function is used to correct a character or move the cursor through the display.

In 2-line displays, the cursor moves to the next line when it passes the last position (40) of the line. When the displayed data is shifted repeatedly all lines shift at the same time; displayed characters do not shift into the next line.

The address counter content does not change if the only action performed is shift display (SC = 1) but increments or decrements with the shift cursor (SC = 0).

10.2.2.6 Set_CGRAM

Table 22. Set_CGRAM bit description

Bit	Symbol	Value	Description
RS	-	0	see Table 11
R/W	-	0	
7 to 6	-	01	fixed value
5 to 0	ACG	000000 to 111111	set CGRAM address

Set_CGRAM: Sets the CGRAM address bits ACG[5:0] into the address counter. Data can then be written to or read from the CGRAM.

Remark: The CGRAM address uses the same address register as the DDRAM address. This register consists of 7 bits. But with the Set_CGRAM command, only bit 5 to bit 0 are set. Bit 6 can be set using the Set_DDRAM command first, or by using the auto-increment feature during CGRAM write. All bits 6 to 0 can be read using the BF_AC instruction.

When writing to the lower part of the CGRAM, ensure that bit 6 of the address is not set (e.g. by an earlier DDRAM write).

10.2.2.7 Set_DDRAM

Table 23. Set_DDRAM bit description

Bit	Symbol	Value	Description
RS	-	0	see Table 11
R/W	-	0	
7	-	1	fixed value
6 to 0	ADD	0000000 to 111111	set DDRAM address

Set_DDRAM: Sets the DDRAM address bits ADD[6:0] into the address counter. Data can then be written to or read from the DDRAM.

10.2.3 Extended instructions (bit H = 1)

10.2.3.1 Screen_conf

Table 24. Screen_conf bit description

Bit	Symbol	Value	Description
RS	-	0	see <u>Table 11</u>
R/W	-	0	
7 to 1	-	000001	fixed value
0	L		screen configuration
		0	split screen standard connection
		1	split screen mirrored connection

Screen_conf:

- If bit L = 0, then the two halves of a split screen are connected in a standard way i.e. column 1/81, 2/82 to 80/160.
- If bit L = 1, then the two halves of a split screen are connected in a mirrored way i.e. column 1/160, 2/159 to 80/81. This allows single layer PCB or glass layout.

10.2.3.2 Disp_conf

Table 25. Disp_conf bit description

Bit	Symbol	Value	Description
RS	-	0	see <u>Table 11</u>
R/W	-	0	
7 to 2	-	000001	fixed value
1	Р		display column configuration
		0	column data: left to right;
			column data is displayed from column 1 to column 80
		1	column data: right to left;
			column data is displayed from column 80 to column 1
0	Q		display row configuration
		0	row data: top to bottom;
			row data is displayed from row 1 to row 16 and icon row data in row 17 and row 18
			in single line mode (SL = 1) row data is displayed from row 1 to row 8 and icon row data in row 17
		1	row data: bottom to top;
			row data is displayed from row 16 to row 1 and icon row data in row 18 and row 17
			in single line mode (SL = 1) row data is displayed from row 8 to row 1 and icon row data in row 17

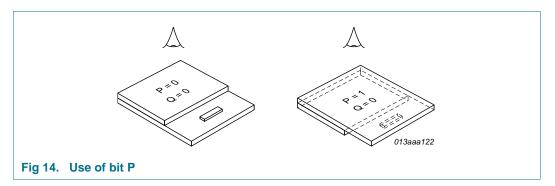
Bit P: The P bit is used to flip the display left to right by mirroring the column data, as shown in <u>Figure 14</u>. This allows the display to be viewed from behind instead of front and enhances the flexibility in the assembly of equipment and avoids complicated data manipulation within the controller.

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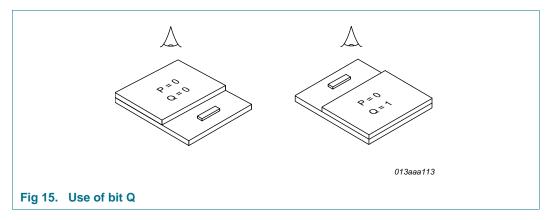
PCF21219

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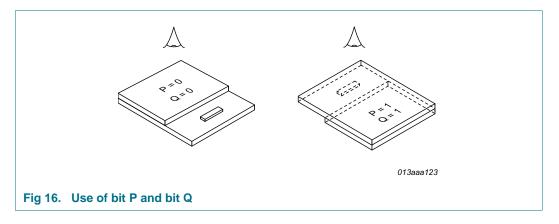
LCD driver for character displays



Bit Q: The Q bit flips the display top to bottom by mirroring the row data, as shown in Figure 15.



Combination of bit P and bit Q: A combination of P and Q allows the display to be rotated horizontally and vertically by 180 degree, as shown in <u>Figure 16</u>. This is useful for viewing the display from the opposite edge.



10.2.3.3 lcon_ctl

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Table 26. Icon_ctl bit description			
Bit	Symbol	Value	Description
RS	-	0	see Table 11
R/W	-	0	
7 to 3	-	00001	fixed value
2	IM		icon mode
		0	character mode, full display
		1	icon mode, only icons displayed
1	-	0	fixed value
0	DM		direct mode
		0	off
		1	on

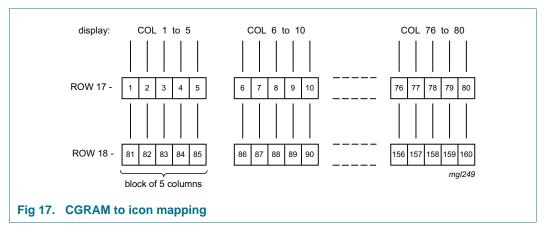
The PCF21219 can drive up to 160 icons, see Figure 17.

Bit IM: When bit IM = 0, the chip is in character mode. In the character mode characters and icons are driven (multiplex drive mode 1:18 or 1:9). The V_{LCD} generator, if used, produces the V_{LCDOUT} voltage programmed with register V_A.

When bit IM = 1, the chip is in icon mode. In the icon mode only the icons are driven (multiplex drive mode 1:2). The V_{LCD} generator, if used, produces the V_{LCDOUT} voltage as programmed with register V_B .

Table 27.	Normal/Icon mode operation	
Bit IM	Mode	VLCDOUT

0 character mode generated from V _A 1 icon mode generated from V _B	BITIM	wode	VLCDOUT
1 icon mode generated from V _B	0	character mode	generated from V _A
	1	icon mode	generated from V _B



Bit DM: When DM = 0, the chip is not in the direct mode. Either the internal V_{LCD} generator or an external voltage may be used to achieve V_{LCD} .

When DM = 1, the chip is in direct mode. The internal V_{LCD} generator is turned off and the output V_{LCDOUT} is directly connected to V_{DD2} (i.e. the V_{LCD} generator supply voltage).

Remark: In direct mode, no external V_{LCD} is possible.

PCF21219

The direct mode can be used to reduce the current consumption when the required output voltage V_{LCDOUT} is close to the V_{DD2} supply voltage. This can be the case in icon mode or in MUX 1:9 (depending on LCD liquid properties).

10.2.3.4 Temp_ctl

Bit Syml	ool Value	Description	
RS -	0	see <u>Table 11</u>	
R/W -	0		
7 to 2 -	000100	fixed value	
1 to 0 TC[1:	0] 00 to 11	temperature coefficient	

The bit-field TC[1:0] selects the temperature coefficient for the internally generated V_{LCDOUT} (see Table 29).

Table 29. TC[1:0] selection of V_{LCD} temperature coefficient

TC[1:0]	Typical value	Description
00	–0.16 %/K	V _{LCD} temperature coefficient 0 (default value)
10	–0.18 %/K	V _{LCD} temperature coefficient 1
01	–0.21 %/K	V _{LCD} temperature coefficient 2
11	–0.24 %/K	V _{LCD} temperature coefficient 3

10.2.3.5 HV_gen

Table 30.	HV_gen bit description	
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Bit	Symbol	Value	Description
RS	-	0	see Table 11
R/W	-	0	
7 to 2	-	010000	fixed value
1 to 0	S[1:0]	00 to 11	voltage multiplier

A software configurable voltage multiplier is incorporated in the V_{LCD} generator and can be set via the HV_gen command. The voltage multiplier control can be used to reduce current consumption by disconnecting internal voltage multiplier stages, depending on the required V_{LCDOUT} output voltage (see <u>Table 31</u>).

Table 31. Voltage multiplier control bits

S[1:0]	Description		
00	set V_{LCD} generator stages to 1 (2 × voltage multiplier)		
01	set V_{LCD} generator stages to 2 (3 × voltage multiplier)		
10	set V _{LCD} generator stages to 3 (4 \times voltage multiplier)		
11	do not use		

10.2.3.6 VLCD_set

Table 32. VLCD_set bit description					
Bit	Symbol	Value	Description		
RS	-	0	see Table 11		
R/W	-	0			
7	-	1	fixed value		
6	V		set register V _A or V _B		
		0	set register V _A		
		1	set register V _B		
5 to 0	V_A or V_B	000000 to 111111	factor for calculating V_{LCD}		

The V_{LCD} value is calculated with the <u>Equation 2 on page 10</u>. The multiplication factor is programmed by instruction. Two on-chip registers (V_A and V_B) hold the multiplication factor for the character mode and the icon mode, respectively. The generated V_{LCDOUT} value is independent of V_{DD}, allowing battery operation of the chip.

V_x programming:

- 1. Send Function_set instruction with bit H = 1.
- 2. Send VLCD_set instruction to write to the voltage register:
 - a. Bit 7 = 1 and bit 6 = 0: bit 5 to bit 0 are the multiplication factor for V_{LCD} of character mode (V_A).
 - b. Bit 7 = 1 and bit 6 = 1: bit 5 to bit 0 are the multiplication factor for V_{LCD} of icon mode (V_B).
 - c. Bit 5 to bit 0 = 0 switches V_{LCD} generator off (when selected).
 - d. During 'display off'/power-down the V_{LCD} generator is also disabled.
- 3. Send Function_set instruction with bit H = 0 to resume normal programming.

11. Basic architecture

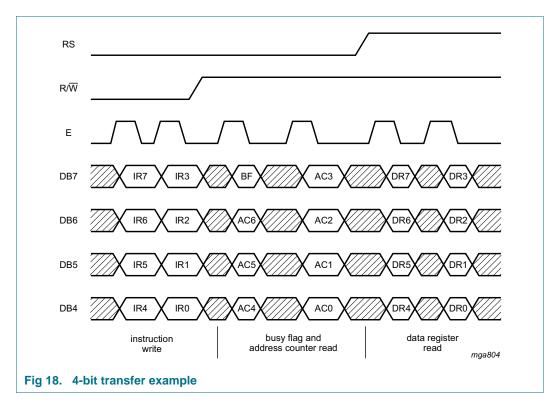
11.1 Parallel interface

The PCF21219 can send data in either two 4-bit operations or one 8-bit operation and can thus interface to 4-bit or 8-bit microcontrollers.

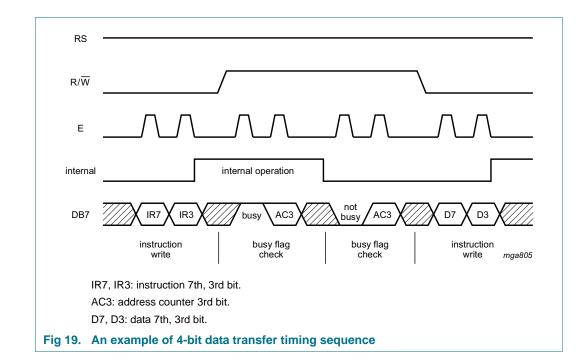
In 8-bit mode data is transferred as 8-bit bytes using the 8 ports DB7 to DB0. Three further control lines E, RS and R/\overline{W} are required.

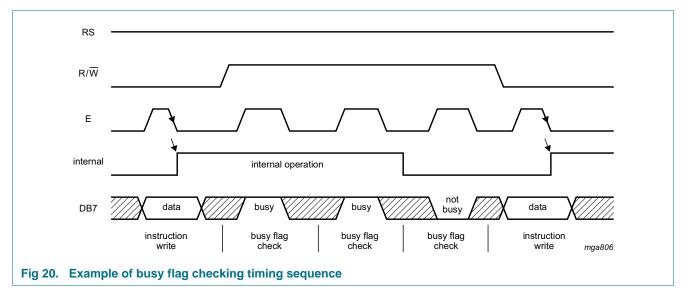
In 4-bit mode data is transferred in two cycles of 4 bits each using ports DB7 to DB4 for the transaction. The higher order bits (corresponding to range of bit 7 to bit 4 in 8-bit mode) are sent in the first cycle and the lower order bits (bit 3 to bit 0 in 8-bit mode) in the second cycle. Data transfer is complete after two 4-bit data transfers. It should be noted that two cycles are also required for the busy flag check. 4-bit operation is selected by instruction (see Figure 18 to Figure 20 for examples of bus protocol).

In 4-bit mode, ports DB3 to DB0 must be left open-circuit. They are pulled up to V_{DD} internally.



LCD driver for character displays





37 of 82

11.2 I²C-bus interface

The I²C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are the Serial DAta line (SDA) and the Serial CLock line (SCL). Both lines must be connected to a positive supply via pull-up resistors. Data transfer may be initiated only when the bus is not busy.

Each byte of eight bits is followed by an acknowledge bit. A slave receiver which is addressed must generate an acknowledge after the reception of each byte.

Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.

The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).

A master receiver must signal an end of data to the transmitter by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

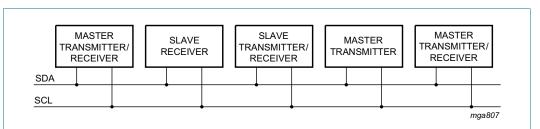
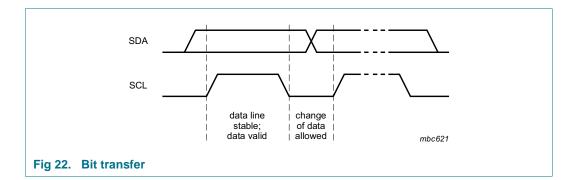
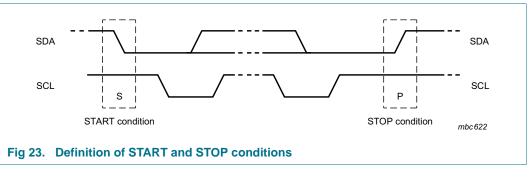


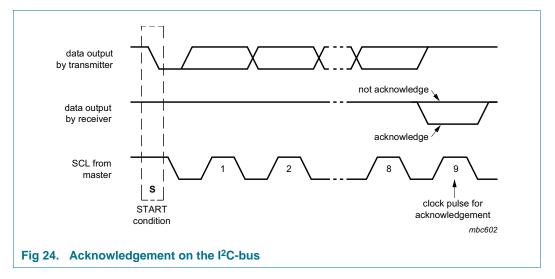
Fig 21. System configuration





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LCD driver for character displays



11.2.1 I²C-bus protocol

Two l^2C -bus slave addresses (0111 010 and 0111 011) are reserved for the PCF21219.The entire l^2C -bus slave address byte is shown in Table 33.

Table 33.I²C slave address byte

	Slave add	lress						
Bit	7	6	5	4	3	2	1	0
	MSB							LSB
	0	1	1	1	0	1	SA0	R/W

Bit 1 of the slave address byte, that a PCF21219 will respond to, is defined by the level tied to its SA0 input (V_{SS} for logic 0 and V_{DD} for logic 1).

Before any data is transmitted on the I²C-bus, the device which should respond is addressed first. The addressing is always carried out with the first byte transmitted after the START procedure.

The I²C-bus configuration for the different PCF21219 read and write cycles is shown in Figure 25 to Figure 27.

The slow down feature of the l^2 C-bus protocol (receiver holds SCL line LOW during internal operations) is not used in the PCF21219.

11.2.2 I²C-bus definitions

Definitions:

- Transmitter: the device which sends the data to the bus.
- Receiver: the device which receives the data from the bus.
- Master: the device which initiates a transfer, generates clock signals and terminates a transfer.
- Slave: the device addressed by a master.
- Multi-master: more than one master can attempt to control the bus at the same time without corrupting the message.

LCD driver for character displays

- Arbitration: procedure to ensure that if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted.
- Synchronization: procedure to synchronize the clock signals of two or more devices.

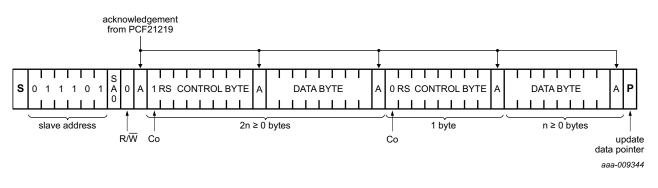
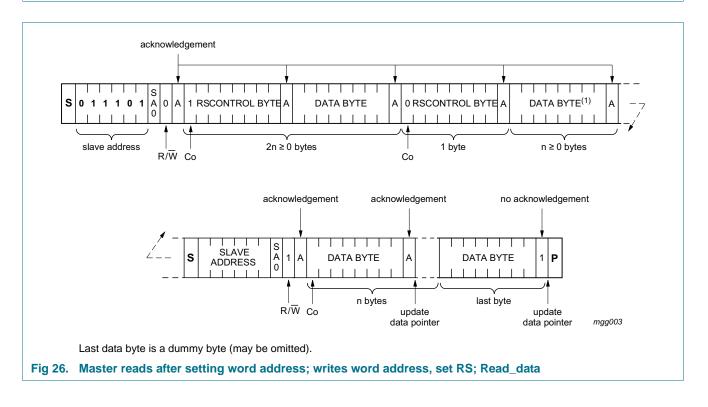
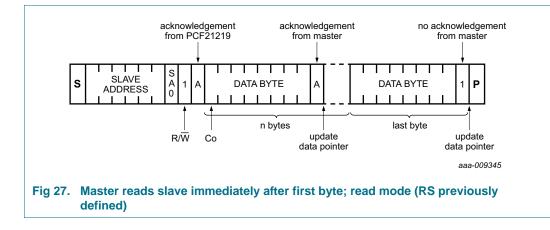


Fig 25. Master transmits to slave receiver; write mode



LCD driver for character displays



11.3 Safety notes

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

CAUTION



Static voltages across the liquid crystal display can build up when the LCD supply voltage (V_{LCD}) is on while the IC supply voltage (V_{DD}) is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts, V_{LCD} and V_{DD} must be applied or removed together.

CAUTION



Semiconductors are light sensitive. Exposure to light sources can cause the IC to malfunction. The IC must be protected against light. The protection must be applied to all sides of the IC.

LCD driver for character displays

12. Internal circuitry

Symbol	Pin	Internal circuit
V _{DD1}	1 to 6	VDD1 VSS1 013aaa169
V _{DD2}	7 to 14	V_{DD2} V_{SS1} V_{SS2} $013aaa170$
V _{DD3}	15 to 18	VDD3 VSS1 013aaa171
V _{SS1}	22 to 29	
V _{SS2}	30 to 35	VSS2 VSS1 013aaa172
V _{LCDSENSE}	36	
V _{LCDIN}	44 to 49	t
V _{LCDOUT}	37 to 43	平 .,
SCL	151 to 152	
SDA	156 to 157	
OSC	168	
PD	155	
POR	154	
T1	20	V _{DD1}
T2	21	
Т3	153	\pm
E	19	V _{SS1}
RS	159	013aaa174
R/W	158	
DB0 to DB7	160 to 167	
R1 to R18	58, 57 to 51, 142 to 149, 59, 100, 141	
C1 to C80	140 to 101, 99 to 60	→ ↓ V _{SS1} 013aaa175

13. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD1}	supply voltage 1	logic	-0.5	+6.5	V
V _{DD2}	supply voltage 2	V _{LCD} generator	-0.5	+4.5	V
V _{DD3}	supply voltage 3				
V _{LCD}	LCD supply voltage		-0.5	+7.5	V
VI	input voltage	V _{DD} related	-0.5	+6.5	V
		V_{LCD} related	-0.5	+7.5	V
l _l	input current	DC current	<u>[1]</u> –10	+10	mA
lo	output current	DC current	<u>[1]</u> –10	+10	mA
I _{DD}	supply current		-50	+50	mA
I _{SS}	ground supply current		-50	+50	mA
I _{DD(LCD)}	LCD supply current		-50	+50	mA
P _{tot}	total power dissipation		-	400	mW
Po	output power	dissipation per output	-	100	mW
V _{ESD}	electrostatic discharge voltage	HBM	[2] _	±3000	V
		MM	[3] _	±300	V
l _{lu}	latch-up current		[4] _	200	mA
T _{stg}	storage temperature		<u>[5]</u> –65	+150	°C
T _{amb}	ambient temperature	operating device	-40	+85	°C

[1] For all diode protected input and output pins.

[2] Pass level; Human Body Model (HBM) according to Ref. 7 "JESD22-A114".

[3] Pass level; Machine Model (MM), according to Ref. 8 "JESD22-A115".

[4] Pass level; latch-up testing according to Ref. 9 "JESD78" at maximum ambient temperature (T_{amb(max)}).

[5] According to the store and transport requirements (see <u>Ref. 12 "UM10569</u>") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

14. Static characteristics

Table 36. Static characteristics

 $V_{DD1} = 2.5 \text{ V to } 5.5 \text{ V}; V_{DD2} = V_{DD3} = 2.5 \text{ V to } 4.0 \text{ V}; V_{SS} = 0 \text{ V}; V_{LCD} = 2.5 \text{ V to } 6.5 \text{ V}; T_{amb} = -40 \text{ °C to } +85 \text{ °C};$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Uni
Supplies							
V _{DD1}	supply voltage 1	logic		2.5	-	5.5	V
V _{DD2}	supply voltage 2	internal V _{LCD} generation;		2.5	-	4.0	V
V _{DD3}	supply voltage 3	$V_{LCD} > V_{DD2} = V_{DD3}$					
V _{LCD}	LCD supply voltage	pins V_{LCD} , V_{LCDIN} , V_{LCDOUT}		2.5	-	6.5	V
Ground supp	ly current using external V _{LCI}	D[1]					
I _{SS}	ground supply current			-	70	120	μA
		$V_{DD} = 3 \text{ V}; V_{LCD} = 5 \text{ V}$	[2]	-	35	80	μA
		icon mode; $V_{DD} = 3 V$; $V_{LCD} = 2.5 V$	[2]	-	25	45	μA
		power-down mode; $V_{DD} = 3 V$; $V_{LCD} = 2.5 V$; DB7 to DB0, RS and R/W = 1; OSC = 0; PD = 1		-	0.5	5	μΑ
Ground supp	ly current using internal V _{LCD}	<u>[1][3]</u>					
I _{SS}	ground supply current			-	190	400	μΑ
		V_{DD} = 3 V; V_{LCD} = 5 V	[2]	-	135	400	μA
		icon mode; V_{DD} = 2.5 V; V_{LCD} = 2.5 V	[2]	-	85	-	μA
Logic V _I	input voltage			-0.5	-	V _{DD1} + 0.5	V
V _{IL}	LOW-level input voltage			V _{SS1}	-	0.3V _{DD1}	V
V _{IH}	HIGH-level input voltage			0.7V _{DD1}	-	V _{DD1}	V
Oscillator inp						551	
V _{IL}	LOW-level input voltage			V _{SS1}	-	V _{DD1} – 1.2	V
V _{IH}	HIGH-level input voltage			V _{DD1} – 0.1	-	V _{DD1}	V
	ns DB7 to DB0						
I _{OL}	LOW-level output current	output sink current; V _{OL} = 0.4 V; V _{DD1} = 5 V		1.6	4	-	mA
I _{ОН}	HIGH-level output current	output source current; V _{OH} = 4 V; V _{DD1} = 5 V		1	8	-	mA
I _{pu}	pull-up current	$V_{I} = V_{SS1}$		0.04	0.15	1	μA
IL	leakage current	$V_{I} = V_{DD1, 2, 3} \text{ or } V_{SS1, 2}$		-1	-	+1	μA
I ² C-bus; pin	s SDA and SCL						
Inputs: pins S	SDA and SCL						
VI	input voltage		<u>[4]</u>	-0.5	-	5.5	V
VIL	LOW-level input voltage			0	-	0.3V _{DD1}	V
V _{IH}	HIGH-level input voltage			0.7V _{DD1}	-	5.5	V
ILI	input leakage current	$V_{I} = V_{DD1, 2, 3} \text{ or } V_{SS1, 2}$		-1		+1	μA



Table 36. Static characteristics ... continued

 $V_{DD1} = 2.5 \text{ V}$ to 5.5 V; $V_{DD2} = V_{DD3} = 2.5 \text{ V}$ to 4.0 V; $V_{SS} = 0 \text{ V}$; $V_{LCD} = 2.5 \text{ V}$ to 6.5 V; $T_{amb} = -40 \text{ °C}$ to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Ci	input capacitance			-	5	-	pF
Output: pin	SDA						
I _{OL}	LOW-level output current	output sink current					
		V _{OL} = 0.4 V		3	-	-	mA
LCD output	ts						
R _O	output resistance	row output, pins R1 to R18	[5]	-	10	30	kΩ
		column output, pins C1 to C80	[5]	-	15	40	kΩ
ΔV_{bias}	bias voltage variation	on pins R1 to R18 and C1 to C80	[6]	-	20	130	mV
ΔV_{LCD}	LCD voltage variation	T _{amb} = 25 °C	[3]				
		$V_{LCD} < 3 V$		-	-	160	mV
		$V_{LCD} < 4 V$		-	-	200	mV
		$V_{LCD} < 5 V$		-	-	260	mV
		$V_{LCD} < 6 V$		-	-	340	mV

[1] LCD outputs are open-circuit; inputs at V_{DD} or $V_{\text{SS}};$ bus inactive.

[2] $T_{amb} = 25 \text{ °C}; f_{osc(ext)} = 200 \text{ kHz}.$

[3] LCD outputs are open-circuit; V_{LCD} generator is on; load current $I_{LCD} = 5 \mu A$.

[4] The I²C-bus interface of PCF21219 is 5 V tolerant.

[5] Resistance of output pins (R1 to R18 and C1 to C80) with a load current of 10 μ A; outputs measured one at a time; external LCD supply V_{LCD} = 3 V; V_{DD1} = V_{DD2} = V_{DD3} = 3 V.

[6] LCD outputs open-circuit; external LCD supply.

15. Dynamic characteristics

Table 37. Dynamic characteristics

 $V_{DD1} = 2.5 \text{ V to } 5.5 \text{ V}; V_{DD2} = V_{DD3} = 2.5 \text{ V to } 4.0 \text{ V}; V_{SS} = 0 \text{ V}; V_{LCD} = 2.5 \text{ V to } 6.5 \text{ V}; T_{amb} = -40 \text{ °C to } +85 \text{ °C}; unless otherwise specified.}$

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
- Clock and o	scillator						
fr(LCD)	LCD frame frequency	internal clock; V _{DD} = 5 V		150	220	300	Hz
osc	oscillator frequency	not available at any pin		461	675	922	kHz
osc(ext)	external oscillator frequency			140	-	1000	kHz
d(startup)(OSC)	start-up delay time on pin OS	C oscillator, after power-down	[1]	-	200	300	μS
Fiming char	acteristics of parallel interface	<u>][2]</u>					
Vrite operati	on (writing data from microcontr	oller to PCF21219); see Figure 2	<u>28</u>				
cy(en)	enable cycle time			500	-	-	ns
w(en)	enable pulse width			220	-	-	ns
su(A)	address set-up time			50	-	-	ns
h(A)	address hold time			25	-	-	ns
su(D)	data input set-up time			60	-	-	ns
h(D)	data input hold time			25	-	-	ns
Read operat	ion (reading data from PCF2121	9 to microcontroller); see Figure	29				
cy(en)	enable cycle time			500	-	-	ns
w(en)	enable pulse width			220	-	-	ns
su(A)	address set-up time			50	-	-	ns
h(A)	address hold time			25	-	-	ns
d(DV)	data input valid delay time			-	-	150	ns
h(D)	data input hold time			20	-	100	ns
iming char	acteristics of I ² C-bus interface	e ^[2] ; see <mark>Figure 30</mark>					
SCL	SCL clock frequency			-	-	400	kHz
LOW	LOW period of the SCL clock	ζ.		1.3	-	-	μS
HIGH	HIGH period of the SCL cloc	k		0.6	-	-	μS
SU;DAT	data set-up time			100	-	-	ns
HD;DAT	data hold time			0	-	-	ns
r	rise time of both SDA and S0 signals	CL	[1][3]	15 + 0.1 C _b	-	300	ns
f	fall time of both SDA and SC signals	L	<u>[1][3]</u>	15 + 0.1 C _b	-	300	ns
b	capacitive load for each bus line			-	-	400	pF
SU;STA	set-up time for a repeated START condition			0.6	-	-	μS
HD;STA	hold time (repeated) START condition			0.6	-	-	μS

Table 37. Dynamic characteristics ...continued

 $V_{DD1} = 2.5 \text{ V to } 5.5 \text{ V}; V_{DD2} = V_{DD3} = 2.5 \text{ V to } 4.0 \text{ V}; V_{SS} = 0 \text{ V}; V_{LCD} = 2.5 \text{ V to } 6.5 \text{ V}; T_{amb} = -40 \text{ °C to } +85 \text{ °C}; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{SU;STO}	set-up time for STOP condition		0.6	-	-	μS
t _{SP}	pulse width of spikes that must be suppressed by the input filter		-	-	50	ns
t _{BUF}	bus free time between a STOP and START condition		1.3	-	-	μS

[1] Tested on sample base.

[2] All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .

[3] C_b = total capacitance of one bus line in pF.

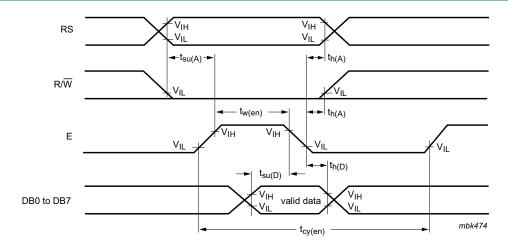
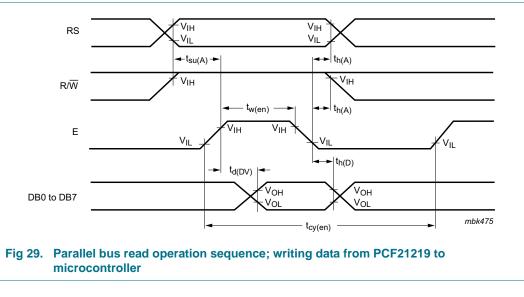
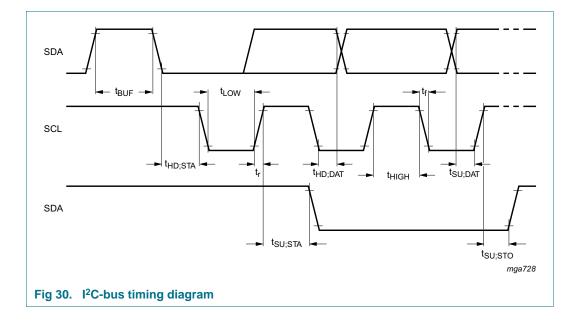


Fig 28. Parallel bus write operation sequence; writing data from microcontroller to PCF21219



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LCD driver for character displays



16. Application information

16.1 General application information

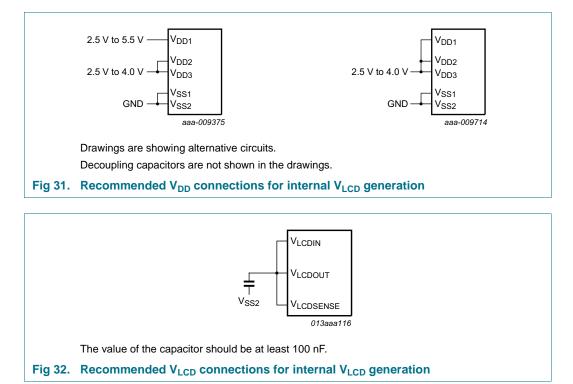
The required minimum value for the external capacitors in an application with the PCF21219 are: C_{ext} from pins V_{LCD} to V_{SS} = 100 nF and for pins V_{DD} to V_{SS} = 470 nF. Higher capacitor values are recommended for ripple reduction.

For COG applications the recommended ITO track resistance is to be minimized for the I/O and supply connections. Optimized values for these tracks are below 50 Ω for the supply and below 100 Ω for the I/O connections. Higher track resistance reduce performance and increase current consumption. To avoid accidental triggering of Power-On Reset (POR) (especially in COG applications), the supplies must be adequately decoupled. Depending on power supply quality, V_{DD1} may have to be risen above the specified minimum.

When external LCD supply voltage is supplied, V_{LCDOUT} should be left open-circuit to avoid any stray current, and V_{LCDIN} must be connected to $V_{LCDSENSE}$.

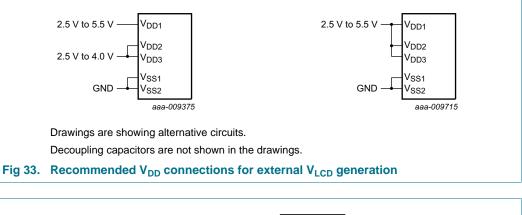
The PCF21219 l²C-bus interface is compatible with systems, where the l²C pull-up resistors are connected to a 5 V \pm 10 % supply.

16.2 Power supply connections for internal V_{LCD} generation

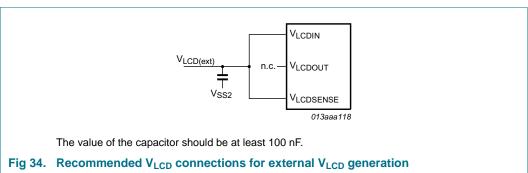


49 of 82

LCD driver for character displays



16.3 Power supply connections for external V_{LCD} generation



Remark: When using an external V_{LCD} , the internal V_{LCD} generator **must never** be switched on and direct mode must be avoided otherwise damages will occur.

16.4 Information about V_{LCD} connections

 V_{LCDIN} — This input is used for generating the 5 LCD bias levels. It is the power supply for the bias level buffers.

 V_{LCDOUT} — This is the V_{LCD} output if V_{LCD} is generated internally. In this case pin V_{LCDOUT} must be connected to V_{LCDIN} and to V_{LCDSENSE}. If V_{LCD} is generated externally, V_{LCDOUT} must be left unconnected.

 $V_{LCDSENSE}$ — This input is used for the voltage multiplier's regulation circuitry. When using the internal V_{LCD} generation, this pin must be connected to V_{LCDOUT} and V_{LCDIN}. When using an external V_{LCD} supply it must be connected to V_{LCDIN} only.

16.5 Reducing current consumption

Reducing current consumption can be achieved by one of the options given in Table 38.

When V_{LCD} lies outside the V_{DD} range and must be generated, it is usually more efficient to use the on-chip V_{LCD} generator than an external regulator.

Original mode	Alternative mode
character mode	icon mode (control bit IM)
display on	display off (control bit D)
V _{LCD} generator operating	direct mode
any mode	power-down mode (pin PD)

Table 38. Reducing current consumption

16.6 Charge pump characteristics

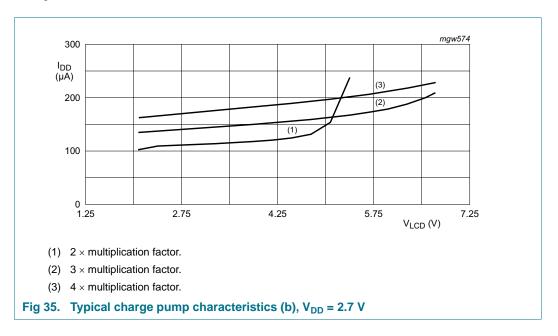
Typical graphs of the total power consumption of the PCF21219 using the internal charge pump are illustrated in Figure 35 and Figure 36.

The graphs were obtained under the following conditions:

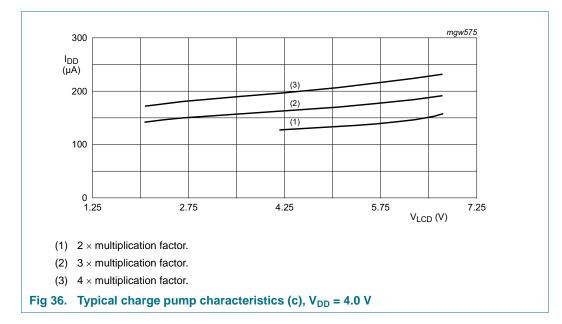
- T_{amb} = 25 °C
- $V_{DD1} = V_{DD2} = V_{DD3} = 2.7 \text{ V} \text{ and } 4.0 \text{ V}$
- Normal mode
- f_{osc} = internal oscillator
- multiplex drive mode 1:18
- Typical current load for $I_{LCD} = 10 \ \mu A$.

For each multiplication factor there is a separate line. The line ends where it is not possible to get a higher voltage under its conditions (a higher multiplication factor is needed to get higher voltages).

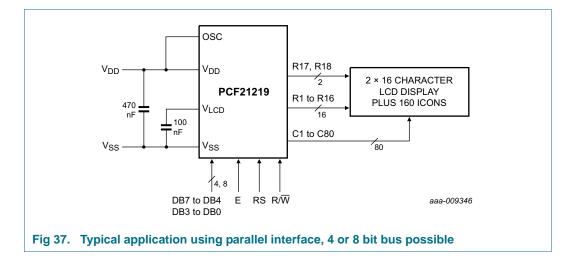
Connecting different displays may result in different current consumption. This affects the efficiency and the optimum multiplication factor to be used to generate a certain output voltage.



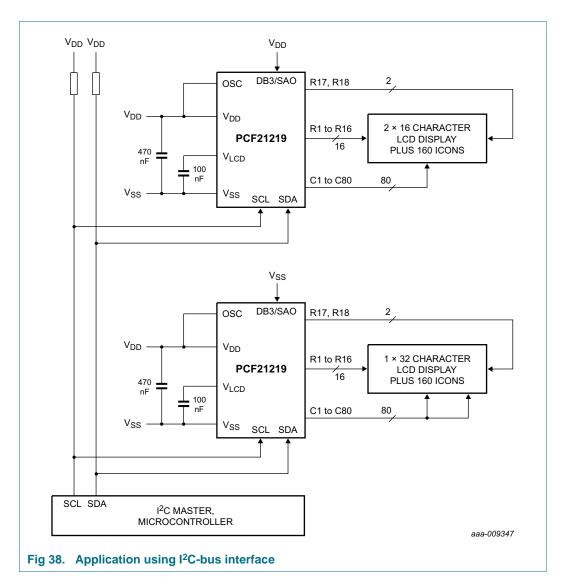
LCD driver for character displays



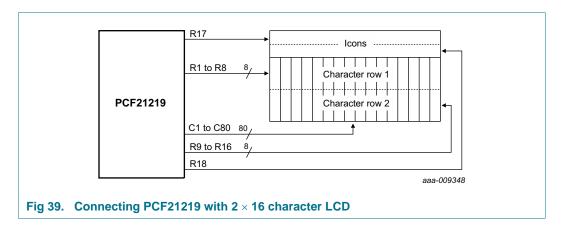
16.7 Interfaces



LCD driver for character displays



16.8 Connections with LCD modules

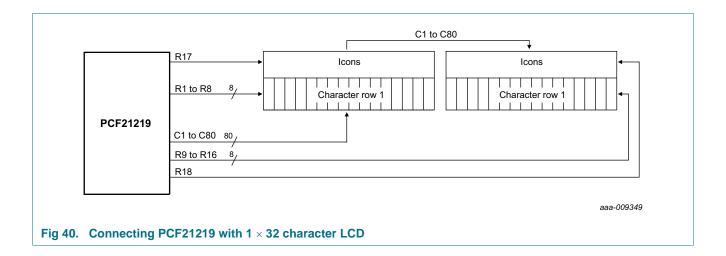


Product data sheet

NXP Semiconductors

PCF21219

LCD driver for character displays



16.9 4-bit operation, 1-line display using external reset

The program must set functions prior to a 4-bit operation (see <u>Table 39</u>). When power is turned on, 8-bit operation is automatically selected and the PCF21219 attempts to perform the first write as an 8-bit operation. Since nothing is connected to ports DB0 to DB3, a rewrite is then required. However, since one operation is completed in two accesses of 4-bit operation, a rewrite is required to set the functions (see <u>Table 39</u> step 3). Thus, DB4 to DB7 of the Function_set are written twice.

Step	Inst	ructior	า				Display	Operation
	RS	R/W	DB7	DB6	DB5	DB4		
1	pow	er supp	oly on					initialized by the external reset; no display appears
2	Fund	ction_s	et					sets to 4-bit operation; in this instance operation is handled as
	0	0	0	0	1	0		8-bit by initialization and only this instruction completes with one write
3	Fund	ction_s	et					sets to 4-bit operation, selects 1-line display and $V_{LCD} = V_0$;
	0	0	0	0	1	0		4-bit operation starts from this point and resetting is needed
	0	0	0	0	0	0		
4	Disp	lay_ctl						turns display and cursor on; entire display is blank after
	0	0	0	0	0	0	_	initialization
	0	0	1	1	1	0		
5	Entr	y_mod	e_set					sets mode to increment the address by 1 and to shift the cursor
	0	0	0	0	0	0	_	to the right at the time of write to the DDRAM or CGRAM;
	0	0	0	1	1	0		display is not shifted
6	Write	e_data	to CG	RAM/	DDRA	Μ		writes 'P'; the DDRAM has already been selected by
	1	0	0	1	0	1	P_	initialization at power-on; the cursor is incremented by 1 and
	1	0	0	0	0	0	1	shifted to the right

Table 39. 4-bit operation, 1-line display example; using external reset (character set 'A')

16.10 8-bit operation, 1-line display using external reset

Table 40 and Table 41 show an example of a 1-line display in 8-bit operation. The PCF21219 functions must be set by the Function_set instruction prior to display. Since the DDRAM can store data for 80 characters, the RAM can be used for advertising displays when combined with display shift operation. Since the display shift operation changes display position only and the DDRAM contents remain unchanged, display data entered first can be displayed when the Return_home operation is performed.

Table 40. 8-bit operation, 1-line display example; using external reset (character set 'A')

Step	Inst	nstruction Display			Display	Operation								
	RS	R/	N DE	37 I	DB6	DB5	DB4	DB3	DB2	DB1	DB0			
1	pov	er su	pply o	on									initialized by the external reset; no display appears	
2	Fur	ction_	set										sets to 8-bit operation, selects 1-line	
	0	0	0	(0	1	1	0	0	0	0		display and $V_{LCD} = V_0$	
3	Dis	olay_o	ctl										turns on display and cursor; entire	
	0	0	0	(0	0	0	1	1	1	0	_	display is blank after initialization	

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LCD driver for character displays

Step	Instr	uctior	1								Display	Operation
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
4	Entry	_mod	e_set									sets mode to increment the address
	0	0	0	0	0	0	0	1	1	0	-	by 1 and to shift the cursor to the right at the time of the write to the DDRAM/CGRAM; display is not shifted
5	Write	_data	to CG	RAM/	DDRA	M						writes 'P'; the DDRAM has already
	1	0	0	1	0	1	0	0	0	0	P_	been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right
6	Write	_data	to CG	RAM/	DDRA	M						writes 'H'
	1	0	0	1	0	0	1	0	0	0	PH_	
7 to 10						:					PHILIP_	writes 'ILIP'
11	Write	_data	to CG	RAM/	DDRA	M						writes 'S'
	1	0	0	1	0	1	0	0	1	1	PHILIPS_	
12	Entry	_mod	e_set									sets mode for display shift at the time
	0	0	0	0	0	0	0	1	1	1	PHILIPS_	of write
13	Write	_data	to CG	RAM/	DDRA	M						writes space
	1	0	0	0	1	0	0	0	0	0	HILIPS _	
14	Write	_data	to CG	RAM/	DDRA	М						writes 'M'
	1	0	0	1	0	0	1	1	0	1	ILIPS M_	
15 to 19						:					MICROK_	writes 'ICROK'
20	Write	_data	to CG	RAM/	DDRA	М						writes 'O'
	1	0	0	1	0	0	1	1	1	1	MICROKO_	
21	Curs_	_disp_	shift									shifts only the cursor position to the left
	0	0	0	0	0	1	0	0	0	0		
22	Curs_	_disp_	shift									shifts only the cursor position to the left
	0	0	0	0	0	1	0	0	0	0	MICRO <u>K</u> O	
23	Write	_data	to CG	RAM/	DDRA	М						writes 'C' correction; display moves to
	1	0	0	1	0	0	0	0	1	1		the left
24	Curs_	_disp_	shift									shifts the display and cursor to the
	0	0	0	0	0	1	1	1	0	0		right
25	Curs_	_disp_	shift									shifts only the cursor to the right
	0	0	0	0	0	1	0	1	0	0	MICROCO_]
26	Write	_data	to CG	RAM/	DDRA	M					1	writes 'M'
	1	0	0	1	0	0	1	1	0	1	ICROCOM_]
27	Retu	n_hor	ne								1	returns both display and cursor to the
	0	0	0	0	0	0	0	0	1	0	PHILIPS M	original position (address 0)
	1		1								1	1

Table 40. 8-bit operation, 1-line display example; using external reset (character set 'A') ... continued

PCF21219 Product data sheet

LCD driver for character displays

Step	Instr	uction	1								Display	Operation
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
1	powe	er supp	oly on									initialized by the external reset; no display appears
2	Fund	tion_s	et									sets to 8-bit operation, selects 1-line
	0	0	0	0	1	1	0	0	0	0		display and $V_{LCD} = V_0$
3	Disp	lay_ctl										turns on display and cursor; entire
	0	0	0	0	0	0	1	1	1	0	_	display is blank after initialization
4	Entry	/_mode	e_set									sets mode to increment the address
	0	0	0	0	0	0	0	1	1	0	-	by 1 and to shift the cursor to the right at the time of the write to the DD/CGRAM; display is not shifted
5	Set_	CGRA	М									sets the CGRAM address to position of
	0	0	0	1	0	0	0	0	0	0	_	character 0; the CGRAM is selected
6	Write	e_data	to CG	RAM/	DDRA	M						writes data to CGRAM for icons; icons
	1	0	0	0	0	0	1	0	1	0	_	appears
7						:					_	
8	Fund	tion_s	et									sets bit H = 1
	0	0	0	0	1	1	0	0	0	1	_	
9	Icon	_ctl										character mode, full display
	0	0	0	0	0	0	1	0	0	0	_	
10	Fund	tion_s	et									sets bit H = 0
	0	0	0	0	1	1	0	0	0	1	_	
11	Set_	DDRA	М									sets the DDRAM address to the first
	0	0	1	0	0	0	0	0	0	0		position; DDRAM is selected
12	Write	e_data	to CG	RAM/	DDRA	M						writes 'P'; the cursor is incremented
	1	0	0	1	0	1	0	0	0	0	P_	by 1 and shifted to the right
13	Write	e_data	to CG	RAM/	DDRA	M						writes 'H'
	1	0	0	1	0	0	1	0	0	0	PH_	
14 to 18						:					PHILIPS_	writes 'ILIPS'
19	Retu	rn_hor	ne									returns both display and cursor to the
	0	0	0	0	0	0	0	0	1	0	P HILIPS	original position (address 0)

Table 41. 8-bit operation, 1-line display and icon example; using external reset (character set 'A')

16.11 8-bit operation, 2-line display

For a 2-line display the cursor automatically moves from the first to the second line after the 40th digit of the first line has been written. Thus, if there are only 8 characters in the first line, the DDRAM address must be set after the 8th character is completed (see <u>Table 42</u>). It should be noted that both lines of the display are always shifted together; data does not shift from one line to the other.

NXP Semiconductors

PCF21219

LCD driver for character displays

	Instr	uction										
Step	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Display	Operation
1	powe	er supp	oly on									initialized by the external reset; no display appears
2	Fund	tion_s	et									sets to 8-bit operation; selects 2-line
	0	0	0	0	1	1	0	1	0	0		display and V_{LCD} generator off
3	displ	ay moo	de on/	off cor	ntrol							turns on display and cursor; entire
	0	0	0	0	0	0	1	1	1	0	_	display is blank after initialization
4	Entry	/_mode	e_set									sets mode to increment the address
	0	0	0	0	0	0	0	1	1	0	-	by 1 and to shift the cursor to the right at the time of write to the CG/DDRAM; display is not shifted
5	Write	e_data	to CG	RAM/	DDRA	M						writes 'P'; the DDRAM has already
	1	0	0	1	0	1	0	0	0	0	P_	been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right
6 to 10						:					PHILIP_	writes 'HILIP'
11	Write	e_data	to CG	RAM/	DDRA	Μ						writes 'S'
	1	0	0	1	0	1	0	0	1	1	PHILIPS_	
12	Set_	DDRA	М									sets DDRAM address to position the
	0	0	1	1	0	0	0	0	0	0	PHILIPS -	cursor at the head of the 2nd line
13	Write	_data	to CG	RAM/	DDR/	١M						writes 'M'
	1	0	0	1	0	0	1	1	0	1	PHILIPS M_	
14 to 18			1			:					PHILIPS MICROC_	writes 'ICROC'
19	Write	e_data	to CG	RAM/	DDRA	M						writes 'O'
	1	0	0	1	0	0	1	1	1	1	PHILIPS MICROCO_	
20	Write	e_data	to CG	RAM/	DDRA	М						sets mode for display shift at the time
	0	0	0	0	0	0	0	1	1	1	PHILIPS MICROCO_	of write
21	Write	e_data	to CG	RAM/	DDRA	M					I	writes 'M'; display is shifted to the left;
	1	0	0	1	0	0	1	1	0	1	HILIPS ICROCOM_	the first and second lines shift together
22						:					:	
23	Retu	rn_hor	ne									returns both display and cursor to the
	0	0	0	0	0	0	0	0	1	0	<u>P</u> HILIPS MICROCOM	original position (address 0)

Table 42. 8-bit operation, 2-line display example; using external reset (character set 'A')

16.12 I²C-bus operation, 1-line display

A control byte is required with most commands (see <u>Table 43</u>).

PCF21219 Product data sheet

LCD driver for character displays

Initialized; no display appears 1 PC-bus start Unitialized; no display appears 2 Slave address for write Unitialized; no display appears 3 SA6 SA4 SA3 SA2 SA1 NA	Table 43.		-		-505 (opera		-inte (лэріа	y (usi	_	
2 slave address for write during the acknowledge cycle SDA will be 3 SA6 SA4 SA3 SA2 SA1 SA0 RW Ack 3 send a control byte for Function.set control byte for Function.set control byte sets RS for following data bytes 4 Function.set selects 1-line display and Viccp = V0; SCL 0 0 0 0 0 0 0 0 5 Display_ctl selects 1-line display and Viccp = V0; SCL pulse during acknowledge cycle starts execution of instruction 5 Display_ctl ums on display and cursor; entire display and Viccp = V0; SCL pulse during acknowledge cycle starts execution of instruction 6 Entry_mode_set sets mode to increment the address by 1 and to shifted ASCI-line character code 20n (blank in ASCI-line character) 7 I ² C-bus start umide to the DRAM or CGRAM; display in dot control byte is needed and to shifted 8 slave address for write slave address for write and to shifted and to shifted 7 I ² C-bus start 0 0 0 0 and to shifted <t< td=""><td>Step</td><td></td><td>-</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>Display</td><td>Operation</td></t<>	Step		-								Display	Operation
SA6 SA3 SA2 SA1 SA0 R/W Ack pulled-down by the PCF21219 3 send a control byte for Function_set control byte sets RS for following data bytes control byte sets RS for following data bytes 4 Send a control byte for B/B D/B D/B D/B Ack selects 1-line display and V _{LCD} = V ₀ ; SCL D/B D/B <td></td>												
SN0 SN0 SN0 SN0 SN0 NM NM <t< td=""><td>2</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></t<>	2											
Send a control byte for Function_set control byte sets RS for following data bytes CO RS 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 <th< td=""><td></td><td>SA6</td><td>SA5</td><td>SA4</td><td>SA3</td><td>SA2</td><td>SA1</td><td>SA0</td><td></td><td>Ack</td><td>-</td><td>pulled-down by the PCF21219</td></th<>		SA6	SA5	SA4	SA3	SA2	SA1	SA0		Ack	-	pulled-down by the PCF21219
CO RS 0 0 0 0 0 Ack 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 <td></td> <td>0</td> <td>1</td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>0</td> <td>0</td> <td>1</td> <td></td> <td></td>		0	1	1	1	0	1	0	0	1		
0 0 0 0 0 0 0 1 4 Function_set selects 1-line display and V _{LCD} = V ₀ ; SCL pulse during acknowledge cycle starts excluding of instruction selects 1-line display and V _{LCD} = V ₀ ; SCL pulse during acknowledge cycle starts excluding of instruction 5 Display_ctl Turns on display and cursor; entire display and cursor; entire display and cursor; entire display shows character code 20h (blank in ASCII-like character sets) 6 Entry_mode_set sets mode to informent the address by 1 and to shift the cursor to the right at the time of write to the DDRAM or CGRAM; display is not shifted 7 I ² C-bus start	3	send	a cont	rol byt	te for I	Functio	on_set	1				control byte sets RS for following data bytes
4 Function_set selects 1-line display and V _{LCD} = V ₀ ; SCL pulse during acknowledge cycle starts execution of instruction 5 Display_cet		CO	RS	0	0	0	0	0	0	Ack	_	
DB6 DB6 DB4 DB3 DB2 DB1 DB0 Ack Pulse during acknowledge cycle starts execution of instruction 5 Displature Displature Uran of the pulse during acknowledge cycle starts execution of instruction Security of instruction		0	0	0	0	0	0	0	0	1		
Image: biols DBS DSS DSS DSS DSS DSS DSS DSS <t< td=""><td>4</td><td>Funct</td><td>ion_se</td><td>ət</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></t<>	4	Funct	ion_se	ət								
0 0 1 X 0 0 0 1 Terms on display and cursor; entire display shows character code 20h (blank in ASCII-like character sets) 5 Display		DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack		
DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Ack		0	0	1	Х	0	0	0	0	1		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	5	Displa	ay_ctl									
0000111016Entry_mode_setsetsets mode to increment the address by 1DB7DB6DB5DB4DB3DB2DB1DB0Ackand to shift the cursor to the right at the time of write to the DDRAM or CGRAM; display is not shifted7 I^2 C-bus start I^2 C-bus start I^2 C-bus start I^2 I^2 I^2 I^2 I^2 8 I^2 C-bus start I^2 I^2 I^2 I^2 I^2 I^2 I^2 I^2 8 I^2 9 I^2 9 I^2 I^2 I^2 I^2 I^2 I^2 I^2 I^2 I^2 9 I^2 I^2 I^2 I^2 I^2 I^2 I^2 I^2 10 I^2 I^2 I^2 I^2 I^2 I^2 I^2 11 V^2 I^2 I^2 I^2 I^2 I^2 I^2 12 I^2 I^2 I^2 I^2 I^2 I^2 I^2 12 I^2 I^2 I^2 I^2 I^2 I^2 I^2 I^2 12 I^2 I^2 I^2 I^2 I^2 I^2 I^2 I^2 12 I^2 I^2 I^2 I^2		DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	_	
DB7 DB6 DB6 DB7 DB6 DB7 DB7 DB6 DB7 DB7 DB0 Ack		0	0	0	0	1	1	1	0	1		ASCII-like character sets)
BB BB<	6	Entry	_mode	e_set							1	
0 0 0 0 1 1 0 1 is not shifted 7 I ² C-bus start I I 0 1 1 0 1 for writing data to DDRAM, RS must be set to 1; therefore a control byte is needed 8 slave address for write SA6 SA4 SA3 SA2 SA1 SA0 RW Ack		DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	_	0
Base Salave Salave <td></td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>-</td> <td></td>		0	0	0	0	0	1	1	0	1	-	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	7	l ² C-b	us stai	rt							_	•
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $												to 1; therefore a control byte is needed
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	8										1	
9 send a control byte for Write_data CO RS 0 0 0 0 0 Ack											-	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		-		-	-	-	-	0	0	1		
	9			-	te for \	Nrite_	data					_
10 Write_data to to to to to to to to to writes 'P', the DDRAM has been selected at power-on; the cursor is incremented by 1 and shifted to the right 10 1 0 1 0 0 0 1 'P'		СО	RS	0	0	0	0	0	0	Ack	_	
$ \begin{array}{ c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		-	-	-	-	0	0	0	0	1		
$ \frac{1}{10} $	10	Write	_data	to DD	RAM							
$ \begin{matrix} 0 & 1 & 0 & 1 & 0 & 0 & 0 & 0 & 0 & 1 \\ \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$		DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	P_	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		0	1	0	1	0	0	0	0	1		
	11	Write	_data	to DDI	RAM							writes 'H'
12 to 15::PHILIP_writes 'ILIP'16Write_data to DDRAMWrite_data to DDRAMwrites 'S'DB7DB6DB5DB4DB3DB2DB1DB0Ack0101011117optional I²C-bus STOPVVVPHILIPS_18I²C-bus startVVVPHILIPS_		DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	PH_	
Mrite_data to DDRAWwrites 'S'16 $Write_data$ to DDR $IIDBADB3DB2DB1DB0AckPHILIPS_01010111117optional I2C-bus STOPVVVVVVVVVVVVVVVVVVVVVVVVVVVVVVVVVVVV$		0	1	0	0	1	0	0	0	1		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	12 to 15					:					PHILIP_	writes 'ILIP'
0 1 0 1 0 1 1 1 17 optional I ² C-bus STOP > > PHILIPS_ 18 I ² C-bus start > > PHILIPS_	16	Write	_data	to DDI	RAM							writes 'S'
17 optional I ² C-bus STOP PHILIPS_ 18 I ² C-bus start PHILIPS_		DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	PHILIPS_	
18 I ² C-bus start PHILIPS_		0	1	0	1	0	0	1	1	1	-	
	17	optior	nal I²C	-bus S	STOP						PHILIPS_	
10 slave address for write	18	l ² C-b	us stai	rt							PHILIPS_	
13 Slave address for write	19	slave	addre	ss for	write							
SA6 SA5 SA4 SA3 SA2 SA1 SA0 R/W Ack PHILIPS_		SA6	SA5	SA4	SA3	SA2	SA1	SA0	R/W	Ack	PHILIPS_	
0 1 1 1 0 1 0 1 1		0	1	1	1	0	1	0	0	1	1	

Table 43. Example of I²C-bus operation; 1-line display (using external reset, assuming pin SA0 = V_{SS})^[1]

PCF21219 Product data sheet

NXP Semiconductors

LCD driver for character displays

Step	l ² C-b	us by	te							Display	Operation
20	contr	ol byte	9								
	CO	RS	0	0	0	0	0	0	Ack	PHILIPS_	
	1	0	0	0	0	0	0	0	1	_	
21	Retu	rn_hor	ne							1	sets DDRAM address 0 in address counter
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	P HILIPS	(also returns shifted display to original
	0	0	0	0	0	0	1	0	1	-	position; DDRAM contents unchanged); this instruction does not update the data register
22	l ² C-b	us sta	rt							P HILIPS	
23	slave	addre	ess for	read						1	during the acknowledge cycle the content of
	SA6	SA5	SA4	SA3	SA2	SA1	SA0	R/W	Ack	P HILIPS	the data register is loaded into the internal
	0	1	1	1	0	1	0	1	1		I ² C-bus interface to be shifted out; in the previous instruction neither a 'set address' nor a Read_data has been performed; therefore the content of the data register was unknown; bit R/W has to be set to logic 1 while still in I ² C-write mode
24	contr	ol byte	e for re	ead							DDRAM content will be read from following
	CO	RS	0	0	0	0	0	0	Ack	P HILIPS	instructions
	0	1	1	0	0	0	0	0	1		
25	Read	l_data	: 8 × S	SCL +	maste	r ackn	owled	ge <mark>[2]</mark>			$8 \times SCL$; content loaded into interface
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	P HILIPS	during previous acknowledge cycle is shifted out over SDA; MSB is DB7; during
	х	Х	Х	Х	Х	Х	Х	Х	0		master acknowledge content of DDRAM address 01 is loaded into the I ² C-bus interface
26	Read	L_data	: 8 × S	SCL +	maste	r ackn	owledg	ge <mark>[2]</mark>		1	$8 \times SCL$; code of letter 'H' is read first;
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	P HILIPS	during master acknowledge code of 'l' is loaded into the l ² C-bus interface
	0	1	0	0	1	0	0	0	0	-	loaded into the PC-bus interface
27	Read	l_data	: 8 × S	SCL +	no ma	ster ad	know	edge	2]	1	no master acknowledge; after the content of
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Ack	P HILIPS	the I ² C-bus interface register is shifted out
	0	1	0	0	1	0	0	1	1		no internal action is performed; no new data is loaded to the interface register, data register is not updated, address counter is not incremented and cursor is not shifted
28	l ² C-b	us ST	OP	1	1	1	1	1	1	PHILIPS	

[1] X = don't care.

[2] SDA is left at high-impedance by the microcontroller during the read acknowledge.

16.13 Initialization

Table 44. Initialization by instruction, 8-bit interface ([1])

Step	Inst	ructior	า								Description
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
1	pow	er-on c	r unkr	iown s	tate						
2	wait	2 ms									after internal reset has been applied
3	Fun	ction_s	et								interface is 8 bits long; BF cannot be checked before
	0	0	0	0	1	1	Х	Х	Х	Х	this instruction
PCF21219				<u> </u>		All info	ormation pr	ovided in th	nis docume	ent is subject	to legal disclaimers. © NXP B.V. 2014. All rights reserved.
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LCD driver for character displays

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Step	Instr	uction	1								Description
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
4	wait 2	2 ms									
5	Func	tion_s	et								interface is 8 bits long; BF cannot be checked before
	0	0	0	0	1	1	Х	Х	Х	Х	this instruction
6	wait r	nore t	han 40)μs							
7	Func	tion_s	et								interface is 8 bits long; BF cannot be checked before
	0	0	0	0	1	1	Х	Х	Х	Х	this instruction
BF can b specified					•		ions; \	when I	3F is r	not che	ecked, the waiting time between instructions is the
8	Func	tion_s	et (inte	erface	is 8 bi	ts long	g)				specify number of display lines
	0	0	0	0	1	1	0	М	0	Н	
9	Displ	ay_ctl									display off
	0	0	0	0	0	0	1	0	0	0	
10	Clear	_displ	ay								
	0	0	0	0	0	0	0	0	0	1	
11	Entry	_mode	e_set								
	0	0	0	0	0	0	0	1	I_D	S	
12	initial	izatior	ends								

 Table 44. Initialization by instruction, 8-bit interface ([1]) ...continued

[1] X = don't care.

LCD driver for character displays

Step	Inst	ructio	n				Description
	RS	R/W	DB7	DB6	DB5	DB4	-
1	pow	er-on o	or unkr	iown s	tate		
2	wait	2 ms a	after in	ternal	reset h	nas be	en applied
3	Fun	ction_s	set				interface is 8 bits long; BF cannot be checked
	0	0	0	0	1	1	before this instruction
4	wait	2 ms					
5	Fun	ction_s	set				interface is 8 bits long; BF cannot be checked
	0	0	0	0	1	1	before this instruction
6	wait	more	than 40) μs			
7	Fun	ction_s	set				interface is 8 bits long; BF cannot be checked
	0	0	0	0	1	1	before this instruction
betwee				op 0 0		aono	on time (see <u>Table 12</u>)
betwee		10110113		00000	04 1110	aono	
betwee 8	Fun	ction_s	et			1	
				0	1	0	set interface to 4 bit long
	Fun 0	ction_s	et 0			1	
8	Fun 0	ction_s	et 0			1	set interface to 4 bit long
8	Fun 0 Fun	ction_s	et 0 set	0	1	0	set interface to 4 bit long interface is 8 bit long
8	Fun 0 Fun 0 0	ction_s	et 0 set 0 0	0	1	0	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long
9	Fun 0 Fun 0 0	ction_s 0 ction_s 0 0	et 0 set 0 0	0	1	0	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long
9	Fun 0 Fun 0 0 Disp	ction_s 0 ction_s 0 0 olay_ct	et 0	0 0 M	1 1 0	0 0 H	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long
9	Fun 0 Fun 0 0 Disp 0 0	ction_s 0 ction_s 0 0 blay_ctl	eet 0 eet 0 0 0 0 1	0 0 M	1 1 0	0 0 H	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long specify number of display line
8 9 10	Fun 0 Fun 0 0 Disp 0 0	ction_s ction_s 0 0 0 blay_ctl 0 0	eet 0 eet 0 0 0 0 1	0 0 M	1 1 0	0 0 H	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long specify number of display line
8 9 10	Fun 0 Fun 0 0 Disp 0 0 0 Clea	ction_s 0 ction_s 0 0 blay_ctl 0 0 ar_disp	eet 0	0 0 M 0 0	1 1 0 0 0	0 0 H 0 0	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long specify number of display line
8 9 10	Fun 0 0 0 0 0 0 0 0 0 0 0 0 0 0	ction_s 0 ction_s 0 0 lay_ctl 0 ar_disp 0	eet 0 0 0 0 1 1 1 1 1 0 0 0	0 M 0 0 0	1 0 0 0 0	0 H 0 0	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long specify number of display line
8 9 10 11	Fun 0 0 0 0 0 0 0 0 0 0 0 0 0 0	ction_s 0 ction_s 0 0 lay_ctl 0 0 ar_disp 0 0 0	eet 0 0 0 0 1 1 1 1 1 0 0 0	0 M 0 0 0	1 0 0 0 0	0 H 0 0	set interface to 4 bit long interface is 8 bit long set interface to 4 bits long specify number of display line

 Table 45.
 Initialization by instruction, 4-bit interface; not applicable for I²C-bus operation

62 of 82

16.14 User defined characters and symbols

Up to 16 user defined characters may be stored in the CGRAM. The content of the CGRAM is lost during power-down, therefore the CGRAM has to be rewritten after every power-on.

	<u> </u>				1
	0	0	1	1	0
	0	1	0	0	1
	0	1	0	0	0
	1	1	1	1	0
	1	1	1	1	0
	0	1	0	0	0
	0	1	0	0	1
	0	0	1	1	0
				013a	aa144
Fig 41. User defined euro currenc	y siç	gn			

Below some source code is printed, which shows how a user defined character is defined - in this case the euro currency sign. The display used is a 2 lines by 16 characters display and the interface is the l^2C -bus:

```
// Write a user defined character into the CGRAM
startI2C();
// PCF21219 slave address for write, SAO is connected to Vdd
SendI2CAddress(0x76);
// MSB (Continuation bit Co) = 0, more than one byte may follow. Bit6, RS=0, next byte
// is command byte
i2c write(0x00);
// 2 lines x 16, 1/18 duty, basic instruction set. Next byte will be another command.
i2c_write(0x24);
// Set CGRAM address to 0
i2c_write(0x40);
// Repeated Start condition
startI2C();
SendI2CAddress(0x76);
// RS=1, next byte is a data byte
i2c_write(0x40);
// Here the data bytes to define the character
// Behind the write commands the 5x8 dot matrix is shown, the 1 represents a on pixel.
// The Euro currency character can be recognized by the 0/1 pattern (see Figure 41)
i2c_write(0x06); // 00110
i2c_write(0x09); // 01001
i2c write(0x08); // 01000
i2c_write(0x1E); // 11110
i2c_write(0x1E); // 11110
i2c write(0x08); // 01000
i2c_write(0x09); // 01001
```

63 of 82

LCD driver for character displays

```
i2c_write(0x06); // 00110
i2c stop();
// Until here the definition of the character and writing it into the CGRAM. Now it
// still needs to be displayed. See below.
// PCF21219, setting of proper display modes
startI2C();
// PCF21219 slave address for write, SAO is connected to Vdd
SendI2CAddress(0x76);
// MSB (Continuation bit Co) = 0, more than one byte may follow. Bit6, RS=0, next byte
// is command byte
i2c_write(0x00);
// 2 lines x 16, 1/18 duty, extended instruction set. Next byte will be another
// command.
i2c_write(0x25);
// Set display configuration to right to left, column 80 to 1. Row data displ. top to
// bottom,1 to 16.
i2c_write(0x06);
// Set to character mode, full display
i2c_write(0x08);
// Set voltage multiplier to 2
i2c_write(0x40);
// Set Vlcd and store in register VA
i2c_write(0xA0);
// Change from extended instruction set to basic instruction set
i2c write(0x24);
// Display control: set display on, cursor off
i2c write(0x0C);
// Entry mode set, increase DDRAM after access, no shift
i2c_write(0x06);
// Return home, set DDRAM address 0 in address counter
i2c write(0x02);
// Clear entire display, set DDRAM address to 0 in address counter
i2c_write(0x01);
// Repeated Start condition because RS needs to be changed from 0 to 1 \,
startI2C();
SendI2CAddress(0x76);
// RS=1, next byte is data
i2c_write(0x40);
// Write the character at address 0, which is the previously defined Euro currency
// character
i2c_write(0x00);
i2c_stop();
```

LCD driver for character displays

17. Bare die outline

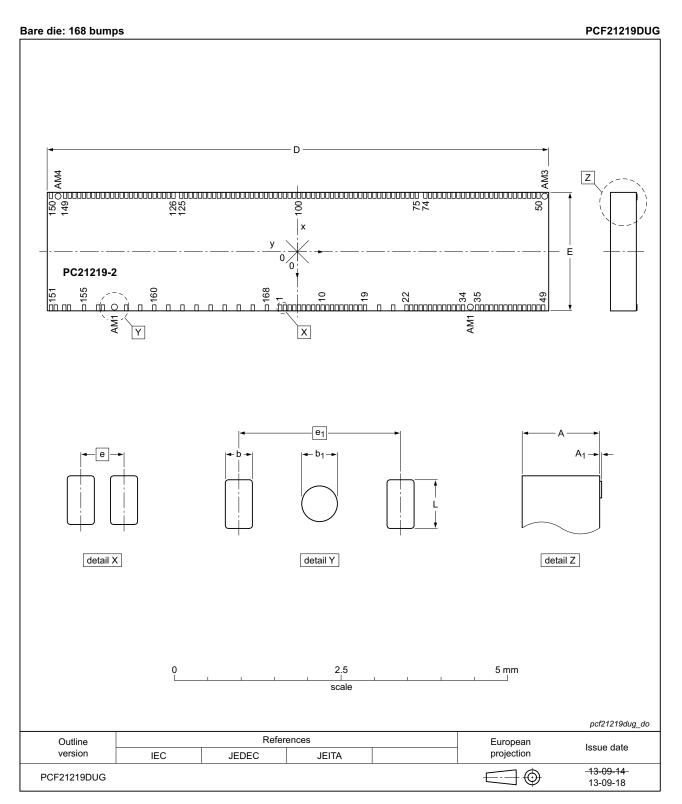


Fig 42. Bare die outline of PCF21219

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Table 46. Dimensions of PCF21219

Original dimer	nsions ar	e in mm.							
Unit (mm)	Α	A ₁	b	b ₁	D	Е	е	e ₁	L
max		0.0225							
nom	0.38	0.0175	0.05	0.1	7.6	1.7	0.07	0.35	0.09
min		0.0125							

Table 47. Pin location

All X and Y coordinates are referenced to the center of the chip (dimensions in μm).

Symbol	Pin	Х	Y	Description
V _{DD1}	1	+745	-274	logic supply voltage 1
V _{DD1}	2	+745	-204	
V _{DD1}	3	+745	-134	
V _{DD1}	4	+745	-64	
V _{DD1}	5	+745	+6	
V _{DD1}	6	+745	+76	
V _{DD2}	7	+745	+146	V _{LCD} generator supply voltage 2
V _{DD2}	8	+745	+216	
V _{DD2}	9	+745	+286	
V _{DD2}	10	+745	+356	
V _{DD2}	11	+745	+426	
V _{DD2}	12	+745	+496	
V _{DD2}	13	+745	+566	
V _{DD2}	14	+745	+636	
V _{DD3}	15	+745	+706	
V _{DD3}	16	+745	+776	
V _{DD3}	17	+745	+846	
V _{DD3}	18	+745	+916	
E	19	+745	+986	data bus clock input
T1	20	+745	+1196	test pin 1
T2	21	+745	+1406	test pin 2
V _{SS1}	22	+745	+1616	ground 1
V _{SS1}	23	+745	+1686	
V _{SS1}	24	+745	+1756	
V _{SS1}	25	+745	+1826	
V _{SS1}	26	+745	+1896	
V _{SS1}	27	+745	+1966	
V _{SS1}	28	+745	+2036	
V _{SS1}	29	+745	+2106	

LCD driver for character displays

Symbol	Pin	Х	Y	Description
V _{SS2}	30	+745	+2176	ground 2
V _{SS2}	31	+745	+2246	
V _{SS2}	32	+745	+2316	
V _{SS2}	33	+745	+2386	
V _{SS2}	34	+745	+2456	
/ _{SS2}	35	+745	+2666	
V _{LCDSENSE}	36	+745	+2736	input for voltage multiplier regulation
V _{LCDOUT}	37	+745	+2806	V _{LCD} output
LCDOUT	38	+745	+2876	
/ _{LCDOUT}	39	+745	+2946	
√ _{LCDOUT}	40	+745	+3016	
LCDOUT	41	+745	+3086	V _{LCD} output
V _{LCDOUT}	42	+745	+3156	
LCDOUT	43	+745	+3226	
/ _{LCDIN}	44	+745	+3296	input for generation of LCD bias levels
√ _{LCDIN}	45	+745	+3366	
/ _{LCDIN}	46	+745	+3436	
/ _{LCDIN}	47	+745	+3506	
	48	+745	+3576	
/ _{LCDIN}	49	+745	+3646	
lummy	50	-745	+3576	dummy
R8	51	-745	+3506	LCD row driver output
R7	52	-745	+3436	
۲6	53	-745	+3366	
₹5	54	-745	+3296	
₹4	55	-745	+3226	
२३	56	-745	+3156	
R2	57	-745	+3086	
٦	58	-745	+3016	
R17	59	-745	+2946	
280	60	-745	+2876	LCD column driver output
C79	61	-745	+2806	
C78	62	-745	+2736	
C77	63	-745	+2666	
276	64	-745	+2596	
C75	65	-745	+2526	
C74	66	-745	+2456	
C73	67	-745	+2386	
273 272	67 68	-745 -745	+2386	

 Table 47.
 Pin location ...continued

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LCD driver for character displays

Symbol	Pin	Х	Y	Description
C70	70	-745	+2176	LCD column driver output
C69	71	-745	+2106	
268	72	-745	+2036	
267	73	-745	+1966	
C66	74	-745	+1896	
C65	75	-745	+1756	
C64	76	-745	+1686	
C63	77	-745	+1616	
C62	78	-745	+1546	
C61	79	-745	+1476	
C60	80	-745	+1406	
C59	81	-745	+1336	
C58	82	-745	+1266	
C57	83	-745	+1196	
C56	84	-745	+1126	
255	85	-745	+1056	
254	86	-745	+986	
253	87	-745	+916	
C52	88	-745	+846	
C51	89	-745	+776	
C50	90	-745	+706	
C49	91	-745	+636	
C48	92	-745	+566	
C47	93	-745	+496	
C46	94	-745	+426	
C45	95	-745	+356	
C44	96	-745	+286	
C43	97	-745	+216	
C42	98	-745	+146	
241	99	-745	+76	
R17DUP	100	-745	+6	LCD row driver output
C40	101	-745	-64	LCD column driver output
239	102	-745	-134	
C38	103	-745	-204	
37	104	-745	-274	
C36	105	-745	-344	
C35	106	-745	-414	
C34	107	-745	-484	
C33	108	-745	-554	
32	109	-745	-624	

Table 47 Din locatio

PCF21219 Product data sheet

LCD driver for character displays

ymbol	Pin	Х	Y	Description
31	110	-745	-694	LCD column driver output
30	111	-745	-764	
29	112	-745	-834	
28	113	-745	-904	
27	114	-745	-974	
26	115	-745	-1044	
25	116	-745	-1114	
24	117	-745	-1184	
23	118	-745	-1254	
22	119	-745	-1324	
21	120	-745	-1394	
20	121	-745	-1464	
19	122	-745	-1534	
18	123	-745	-1604	
17	124	-745	-1674	
16	125	-745	-1744	
15	126	-745	-1884	
14	127	-745	-1954	
13	128	-745	-2024	
12	129	-745	-2094	
11	130	-745	-2164	
10	131	-745	-2234	
9	132	-745	-2304	
8	133	-745	-2374	
7	134	-745	-2444	
6	135	-745	-2514	
5	136	-745	-2584	
4	137	-745	-2654	
3	138	-745	-2724	
2	139	-745	-2794	
1	140	-745	-2864	
18	141	-745	-2934	LCD row driver output
9	142	-745	-3004	
10	143	-745	-3074	
11	144	-745	-3144	
12	145	-745	-3214	
13	146	-745	-3284	
14	147	-745	-3354	
15	148	-745	-3424	

LCD driver for character displays

Symbol	Pin	Х	Y	Description
dummy	150	-745	-3704	dummy
SCL	151	+745	-3704	I ² C-bus serial clock input
SCL	152	+745	-3634	
Т3	153	+745	-3494	test pin 3
POR	154	+745	-3424	external Power-On Reset (POR) input
PD	155	+745	-3214	power-down mode select input
SDA	156	+745	-3004	I ² C-bus serial data input/output
SDA	157	+745	-2934	
R/W	158	+745	-2584	read/write input
RS	159	+745	-2374	register select input
DB0	160	+745	-2164	8-bit bidirectional data bus; bit 0
DB1	161	+745	-1954	8-bit bidirectional data bus; bit 1
DB2	162	+745	-1744	8-bit bidirectional data bus; bit 2
DB3/SA0	163	+745	-1534	8-bit bidirectional data bus; bit 3
DB4	164	+745	-1324	8-bit bidirectional data bus; bit 4
DB5	165	+745	-1114	8-bit bidirectional data bus; bit 5
DB6	166	+745	-904	8-bit bidirectional data bus; bit 6
DB7	167	+745	-694	8-bit bidirectional data bus; bit 7
OSC	168	+745	-484	oscillator or external clock input

Table 47. Pin location ...continued

Table 48. Alignment mark location

All X and Y coordinates are referenced to the center of the chip (dimensions in μm).

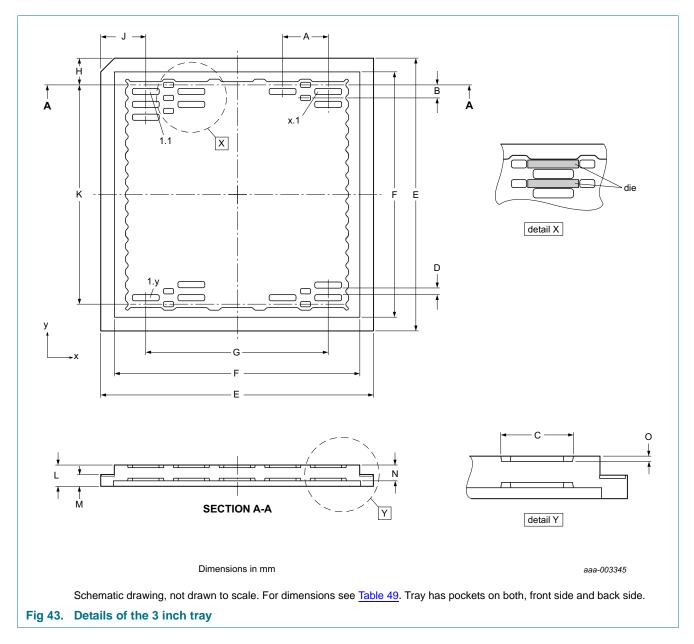
Symbol	Pin	X	Y	
AM1	-	+745	-2689	
AM2	-	+745	+2561	
AM3	-	-745	+3681	
AM4	-	-745	-3599	

18. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

LCD driver for character displays

19. Packing information

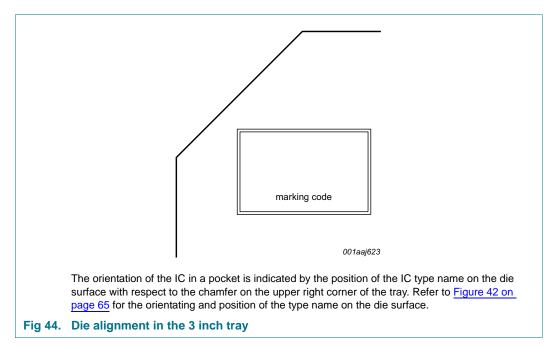


19.1 Packing information on the tray

Table 49. Specification of 3 inch tray details

Tray details are shown in Figure 43. Nominal values without production tolerances.

Tray	details													
Dime	nsions													
A	В	С	D	Е	F	G	Н	J	K	L	Μ	Ν	0	Unit
9.5	3.0	7.69	1.81	76.0	68.0	57.0	6.5	9.5	63	4.2	2.6	3.2	0.50	mm
Numl	per of po	ockets												
x dire	ction						y dire	ction						
7							22							



LCD driver for character displays

20.1 LCD character driver selection

Table 50. Selection of LCD character drivers

All character drivers are bare die with gold bumps.

	Type name	Nun	nber	of			V _{DD1} (V) V _{DD2} (V)	V _{DD2} (V)	V _{LCD} (V)	f _{fr} (Hz)	V _{LCD} (V)	V _{LCD} (V)	T _{amb} (°C)		AEC-
		Line	es		lcons	set					charge	temperature			Q100
		1 ×	2 ×	4 ×							pump	compensat.			
		Cha	racte	ers											
⊳	PCF2113AU	24	12	-	120	A	1.8 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l²C, parallel	Ν
All information provided in this document is subject to legal disclaimers Rev. 1 — 14 January 2014	PCF2113DU	24	12	-	120	D	1.8 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l ² C, parallel	N
Rev. 1	PCF2113EU	24	12	-	120	E	1.8 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l ² C, parallel	Ν
n this docum	PCF2113WU	24	12	-	120	W	1.8 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l ² C, parallel	Ν
s document is subject to legs 14 January 2014	PCF2116AU	24	24	12	-	A	2.5 to 6	2.5 to 6	3.5 to 9	65	Y	Ν	-40 to 85	l²C, parallel	N
ct to legal d	PCF2116CU	24	24	12	-	С	2.5 to 6	2.5 to 6	3.5 to 9	65	Y	Ν	-40 to 85	l ² C, parallel	N
isclaimers.	PCF2119AU	32	16	-	160	A	1.5 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l²C, parallel	N
	PCF2119DU	32	16	-	160	S	1.5 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l ² C, parallel	N
	PCF2119FU	32	16	-	160	F	1.5 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l ² C, parallel	Ν
	PCF2119IU	32	16	-	160	Ι	1.5 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l ² C, parallel	Ν
© NXP B	PCF2119RU	32	16	-	160	R	1.5 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l²C, parallel	Ν
.V. 2014. All	PCF2119SU	32	16	-	160	S	1.5 to 5.5	2.2 to 4	2.2 to 6.5	95	Y	Y	-40 to 85	l²C, parallel	Ν
© NXP B.V. 2014. All rights reserved. 73 of 82	PCF21219DUGR	32	16	-	160	R	2.5 to 5.5	2.5 to 4	2.5 to 6.5	220	Y	Y	-40 to 85	l ² C, parallel	Ν

Product data sheet PCF21219 20. Appendix

Table 50. Selection of LCD character drivers ...continued PCF21219

All character drivers are bare die with gold bumps.

Type name	Num	ber (of		Character	V _{DD1} (V)	V _{DD2} (V)	V _{LCD} (V)	f _{fr} (Hz)			T _{amb} (°C)	Interface	AEC-
	Line	S		lcons	set					charge pump	temperature compensat.			Q100
	1 ×	2 ×	4 ×							pump	compensat.			
	Cha	racte	rs											
PCF2117DUGR	40	20	-	200	R	2.5 to 5.5	2.5 to 5.5	4 to 16	45 to 360[1]	Y	Y	-40 to 85	I ² C, SPI	Ν
PCA2117DUGR	40	20	-	200	R	2.5 to 5.5	2.5 to 5.5	4 to 16	45 to 360[1]	Y	Y	-40 to 105	I ² C, SPI	Y
PCF2117DUGS	40	20	-	200	S	2.5 to 5.5	2.5 to 5.5	4 to 16	45 to 360[1]	Y	Y	-40 to 85	I ² C, SPI	Ν
PCA2117DUGS	40	20	-	200	S	2.5 to 5.5	2.5 to 5.5	4 to 16	45 to 360[1]	Υ	Y	-40 to 105	I ² C, SPI	Y

[1] Can be selected by command.

Product data sheet

LCD driver for character displays

21. Abbreviations

Table 51.	Abbreviations
Acronym	Description
CGRAM	Character Generator RAM
CGROM	Character Generator ROM
CMOS	Complementary Metal-Oxide Semiconductor
COG	Chip-On-Glass
DC	Direct Current
DDRAM	Display Data RAM
HBM	Human Body Model
l ² C	Inter-Integrated Circuit
IC	Integrated Circuit
ITO	Indium Tin Oxide
LCD	Liquid Crystal Display
LSB	Least Significant Bit
MM	Machine Model
MSB	Most Significant Bit
MUX	Multiplexer
PCB	Printed-Circuit Board
PI	Polyimide
POR	Power-On Reset
RAM	Random Access Memory
RMS	Root Mean Square
ROM	Read Only Memory
SCL	Serial CLock line
SDA	Serial DAta line

22. References

- [1] AN10170 Design guidelines for COG modules with NXP monochrome LCD drivers
- [2] AN10706 Handling bare die
- [3] AN10853 ESD and EMC sensitivity of IC
- [4] AN11267 EMC and system level ESD design guidelines for LCD drivers
- [5] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [6] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [7] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [8] JESD22-A115 Electrostatic Discharge (ESD) Sensitivity Testing Machine Model (MM)
- [9] JESD78 IC Latch-Up Test
- [10] JESD625-A Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [11] UM10204 I²C-bus specification and user manual
- [12] UM10569 Store and transport requirements

23. Revision history

Table 52.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCF21219 v.1	20140114	Product data sheet	-	-

24. Legal information

24.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PCF21219

LCD driver for character displays

26. Tables

Table 1.	Ordering information	3	Table 47.	Pin loca
Table 2.	Ordering options	3	Table 48.	Alignme
Table 3.	Marking codes	3	Table 49.	Specific
Table 4.	Pin description	6	Table 50.	Selectio
Table 5.	State after reset	9	Table 51.	Abbrevi
Table 6.	Values of V_A and V_B and the corresponding		Table 52.	Revisio
	V _{LCD} values	.10		
Table 7.	Bias levels as a function of multiplex rate	.12		
Table 8.	Address space and wrap-around operation	.18		
Table 9.	Instruction set for I ² C-bus commands			
Table 10.	Control byte bit description			
	Register access selection			
	Instruction register overview			
	Function_set bit description			
	BF_AC bit			
	Read_data bit description			
	Write_data bit description			
	Clear_display bit description			
	Return_home bit description			
	Entry_mode_set bit description			
	Display_ctl bit description			
	Curs_disp_shift bit description			
	Set_CGRAM bit description			
	Set_DDRAM bit description			
	Screen_conf bit description			
	Disp_conf bit description			
	Icon_ctl bit description			
	Normal/icon mode operation			
	Temp_ctl bit description	.34		
Table 29.	TC[1:0] selection of V _{LCD} temperature	24		
T 1 1 00	coefficient			
	HV_gen bit description			
	Voltage multiplier control bits			
	VLCD_set bit description			
	I ² C slave address byte			
	Device protection circuits			
	Limiting values			
	Static characteristics			
	Dynamic characteristics			
	Reducing current consumption	.51		
Table 39.	4-bit operation, 1-line display example;			
	using external reset (character set 'A')	.55		
Table 40.	8-bit operation, 1-line display example;			
	using external reset (character set 'A')	.55		
Table 41.	8-bit operation, 1-line display and icon			
	example; using external			
	reset (character set 'A')	.57		
Table 42.	8-bit operation, 2-line display example;			
	using external reset (character set 'A')	.58		
Table 43.	Example of I ² C-bus operation; 1-line display			
	(using external reset, assuming			
	pin SA0 = V_{SS}) ^[1]	.59		
Table 44.	Initialization by instruction, 8-bit interface ([1])			
	Initialization by instruction, 4-bit interface; not			
	applicable for I ² C-bus operation	.62		
Table 46.	Dimensions of PCF21219			
PCF21219	All information provided in	this docume	nt is subject to lega	al disclaimers.

	Pin location
Table 48.	Alignment mark location70
Table 49.	Specification of 3 inch tray details72
Table 50.	Selection of LCD character drivers73
Table 51.	Abbreviations75
Table 52.	Revision history

LCD driver for character displays

27. Figures

Fig 1. Fig 2.	Block diagram of PCF212194 Pinning diagram of PCF212195
Fig 3.	Electro-optical characteristic: relative transmission
Fig 4.	curve of the liquid
9	with 5 bias levels; character mode
Fig 5.	Waveforms for the 1:9 multiplex drive mode with 5 bias levels; character mode, R9 to R16 and
	R18 open
Fig 6.	Waveforms for the 1:2 multiplex drive mode
	with 4 bias levels; icon mode
Fig 7.	DDRAM to display mapping: no shift
Fig 8.	DDRAM to display mapping: right shift17
Fig 9.	DDRAM to display mapping: left shift
Fig 10.	Character set 'R' in CGROM19
Fig 11.	Relationship between CGRAM addresses,
	data and display patterns
Fig 12.	Cursor display example
Fig 13.	Example of displays with icons
Fig 14.	Use of bit P
Fig 15.	Use of bit Q
Fig 16.	Use of bit P and bit Q32
Fig 17.	CGRAM to icon mapping
Fig 18.	4-bit transfer example
Fig 19.	An example of 4-bit data transfer timing
	sequence
Fig 20.	Example of busy flag checking timing sequence.37
Fig 21.	System configuration
Fig 22.	Bit transfer
Fig 23.	Definition of START and STOP conditions
Fig 24.	Acknowledgement on the I ² C-bus
Fig 25.	Master transmits to slave receiver; write mode40
Fig 26.	Master reads after setting word address; writes word address, set RS; Read_data40
Fig 27.	Master reads slave immediately after first byte;
1 ig 27.	read mode (RS previously defined)
Fig 28.	Parallel bus write operation sequence; writing
	data from microcontroller to PCF2121947
Fig 29.	Parallel bus read operation sequence; writing
F ' 00	data from PCF21219 to microcontroller47
Fig 30.	I ² C-bus timing diagram
Fig 31.	Recommended V _{DD} connections for internal V _{LCD} generation
Fig 32.	Recommended V_{LCD} connections for internal
	V _{LCD} generation
Fig 33.	Recommended V _{DD} connections for external
	V _{LCD} generation
Fig 34.	Recommended V_{LCD} connections for external
	V _{LCD} generation
Fig 35.	Typical charge pump characteristics (b),
Eig 26	$V_{DD} = 2.7 V \dots 51$
Fig 36.	Typical charge pump characteristics (c), $V_{DD} = 4.0 V \dots 52$
Fig 37.	Typical application using parallel interface,
	4 or 8 bit bus possible
Fig 38.	Application using l^2 C-bus interface
U	
PCF21219	All information provided in this doc

Fig 39.	Connecting PCF21219 with 2 × 16 character LCD
Fig 40.	Connecting PCF21219 with 1×32 character LCD
Fia 41.	User defined euro currency sign
	Bare die outline of PCF2121965
	Details of the 3 inch tray71
Fig 44.	Die alignment in the 3 inch tray72

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LCD driver for character displays

28. Contents

1	General description	. 1
2	Features and benefits	. 1
3	Applications	. 2
4	Ordering information	. 3
4.1	Ordering options	
5	Marking	. 3
6	Block diagram	
7	Pinning information	
7.1	Pinning	
7.2	Pin description	
8	Functional description	. 8
8.1	Oscillator and timing generator	. 8
8.1.1	Timing generator	
8.1.2	Internal clock	
8.1.3	External clock	
8.2	Reset function and Power-On Reset (POR)	
8.3 8.4	Power-down mode	
o.4 8.4.1	LCD supply voltage generator Programming ranges	
8.5	LCD bias voltage generator	
8.5.1	Electro-optical performance	
8.6	LCD row and column drivers	
9	Display data RAM and ROM	
9.1	DDRAM	
9.2	CGROM	18
9.3	CGRAM	
9.4	Cursor control circuit	21
10	Registers	22
10.1	Data register	
10.2	Instruction register	
10.2.1	Basic instructions (bit H = 0 or 1)	
10.2.1.1		
10.2.1.2		
10.2.1.3	—	
10.2.1.4	Standard instructions (bit H = 0)	
10.2.2.1	· · · · · ·	
10.2.2.2		
10.2.2.3		
10.2.2.4		
10.2.2.5		
10.2.2.6	—	
10.2.2.7		
10.2.3	Extended instructions (bit H = 1)	
10.2.3.1 10.2.3.2	Screen_conf Disp_conf	
10.2.3.2	hp_colli	51

10.2.3.3	lcon_ctl	33
10.2.3.4	—	34
10.2.3.5		34
10.2.3.6		35
11	Basic architecture	36
11.1	Parallel interface	36
11.2	l ² C-bus interface	38
11.2.1	l ² C-bus protocol	39
11.2.2	I ² C-bus definitions	39
11.3	Safety notes	41
12	Internal circuitry	42
13	Limiting values	43
14	Static characteristics	44
15	Dynamic characteristics	46
16	Application information	49
16.1	General application information	49
16.2	Power supply connections for internal V _{LCD}	
	generation	49
16.3	Power supply connections for external V _{LCD}	
	generation	50
16.4	Information about V _{LCD} connections	50
16.5	Reducing current consumption	50
16.6	Charge pump characteristics	51
16.7	Interfaces	52
16.8	Connections with LCD modules	53
16.9	4-bit operation, 1-line display using external reset	55
16.10	8-bit operation, 1-line display using	
	external reset	55
16.11	8-bit operation, 2-line display	57
16.12	I ² C-bus operation, 1-line display	58
16.13	Initialization	60
16.14	User defined characters and symbols	63
17	Bare die outline	65
18	Handling information	70
19	Packing information	71
19.1	Packing information on the tray	71
20	Appendix	73
20.1	LCD character driver selection	73
21	Abbreviations	75
22	References	76
23	Revision history	76
24	Legal information	77
24.1	Data sheet status	77
24.2	Definitions	77

continued >>

NXP Semiconductors

PCF21219

LCD driver for character displays

	Disclaimers	
24.4	Trademarks 78	
25	Contact information 78	
26	Tables	
27	Figures	
28	Contents 81	

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